# Regarding the change of names mentioned in the document, such as Mitsubishi Electric and Mitsubishi XX, to Renesas Technology Corp. 

The semiconductor operations of Hitachi and Mitsubishi Electric were transferred to Renesas Technology Corporation on April 1st 2003. These operations include microcomputer, logic, analog and discrete devices, and memory chips other than DRAMs (flash memory, SRAMs etc.) Accordingly, although Mitsubishi Electric, Mitsubishi Electric Corporation, Mitsubishi Semiconductors, and other Mitsubishi brand names are mentioned in the document, these names have in fact all been changed to Renesas Technology Corp. Thank you for your understanding. Except for our corporate trademark, logo and corporate statement, no changes whatsoever have been made to the contents of the document, and these changes do not constitute any alteration to the contents of the document itself.

Note : Mitsubishi Electric will continue the business operations of high frequency \& optical devices and power devices.

Renesas Technology Corp. Customer Support Dept.
April 1, 2003

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

## DESCRIPTION

The 3822 group is the 8 -bit microcomputer based on the 740 family core technology.
The 3822 group has the LCD drive control circuit, an 8-channel A-D converter, and a serial I/O as additional functions.
The various microcomputers in the 3822 group include variations of internal memory size and packaging. For details, refer to the section on part numbering.
For details on availability of microcomputers in the 3822 group, refer to the section on group expansion.

## FEATURES

- Basic machine-language instructions71
- The minimum instruction execution time ..... $0.5 \mu \mathrm{~s}$
(at 8 MHz oscillation frequency)
- Memory size

ROM ............................................................... 4 K to 48 K bytes
RAM
192 to 1024 bytes

- Programmable input/output ports

49

- Software pull-up/pull-down resistors (Ports P0-P7 except port P4o) - Interrupts $\qquad$ 17 sources, 16 vectors (includes key input interrupt)
- Timers $\qquad$ 8 -bit $\times 3,16$-bit $\times 2$
- Serial I/O $\qquad$ . 8 -bit $\times 1$ (UART or Clock-synchronized)
- A-D converter $\qquad$ 8 -bit $\times 8$ channels
- LCD drive control circuit

Bias 1/2, 1/3
Duty
$1 / 2,1 / 3,1 / 4$
Common output ......................................................................... 4
Segment output ......................................................................... 32

- 2 clock generating circuits
(connect to external ceramic resonator or quartz-crystal oscillator)
- Power source voltage

In high-speed mode
4.0 to 5.5 V

In middle-speed mode
2.5 to 5.5 V
(Extended operating temperature version:
2.0 to $5.5 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$
3.0 to $5.5 \mathrm{~V}, \mathrm{Ta}=-40$ to $-20^{\circ} \mathrm{C}$ )
(One time PROM version: 2.5 to 5.5 V )
( M version: 2.2 to 5.5 V )
(H version: 2.0 to 5.5 V )
In low-speed mode
2.5 to 5.5 V
(Extended operating temperature version:
2.0 to $5.5 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$
3.0 to $5.5 \mathrm{~V}, \mathrm{Ta}=-40$ to $-20^{\circ} \mathrm{C}$ )
(One time PROM version: 2.5 to 5.5 V )
(M version: 2.2 to 5.5 V )
( H version: 2.0 to 5.5 V )
Power dissipation
In high-speed mode ........................................................... 32 mW
(at 8 MHz oscillation frequency, at 5 V power source voltage)
In low-speed mode ........................................................... $45 \mu \mathrm{~W}$
(at 32 kHz oscillation frequency, at 3 V power source voltage)

- Operating temperature range
-20 to $85^{\circ} \mathrm{C}$
(Extended operating temperature version: -40 to $85^{\circ} \mathrm{C}$ )


## APPLICATIONS

Camera, household appliances, consumer electronics, etc.

## PIN CONFIGURATION (TOP VIEW)



Package type : 80P6N-A (80-pin plastic-molded QFP)
Fig. 1 M38224M6HXXXFP pin configuration
(The pin configuration of 80DO is same as this.)

## PIN CONFIGURATION (TOP VIEW)



Fig. 2 M38223M4MXXXGP/M38224M6HXXXHP pin configuration


Fig. 3 Functional block diagram

## PIN DESCRIPTION

Table 1 Pin description (1)

| Pin | Name | Function | Function except a port function |
| :---: | :---: | :---: | :---: |
| Vcc, Vss | Power source | -Apply voltage of power source to Vcc, and 0 V to Vss. (For the limits of Vcc, refer to "Recommended operating conditions"). |  |
| VREF | Analog reference voltage | -Reference voltage input pin for A-D converter. |  |
| AVss | Analog power source | -GND input pin for A-D converter. <br> -Connect to Vss. |  |
| RESET | Reset input | $\bullet$ Reset input pin for active "L". |  |
| XIN | Clock input | - Input and output pins for the main clock generating circuit. <br> -Feedback resistor is built in between XIN pin and Xout pin. <br> -Connect a ceramic resonator or a quartz-crystal oscillator between the XIN and Xout pins to set the oscillation frequency. <br> - If an external clock is used, connect the clock source to the XIN pin and leave the Xout pin open. <br> -This clock is used as the oscillating source of system clock. |  |
| XOUT | Clock output |  |  |
| VL1-VL3 | LCD power source | -Input $0 \leq$ VL1 $\leq$ VL2 $\leq$ VL3 $\leq$ VCC voltage. <br> - Input 0 - VL3 voltage to LCD. |  |
| COM0-COM3 | Common output | -LCD common output pins. <br> - COM 2 and COM 3 are not used at $1 / 2$ duty ratio. <br> $\cdot \mathrm{COM} 3$ is not used at $1 / 3$ duty ratio. |  |
| SEG0-SEG11 | Segment output | -LCD segment output pins. |  |
| $\begin{aligned} & \text { P00/SEG16- } \\ & \text { P07/SEG23 } \end{aligned}$ | I/O port P0 | -8-bit output port. <br> -CMOS compatible input level. <br> -CMOS 3-state output structure. | -LCD segment output pins |
| $\begin{aligned} & \text { P10/SEG24- } \\ & \text { P17/SEG31 } \end{aligned}$ | I/O port P1 | -I/O direction register allows each port to be individually programmed as either input or output. <br> -Pull-down control is enabled. |  |
| P20-P27 | I/O port P2 | -8-bit I/O port. <br> -CMOS compatible input level. <br> -CMOS 3-state output structure. <br> -I/O direction register allows each pin to be individually programmed as either input or output. <br> -Pull-up control is enabled. | -Key input (key-on wake-up) interrupt input pins |
| $\begin{aligned} & \text { P34/SEG12 - } \\ & \text { P37/SEG15 } \end{aligned}$ | Input port P3 | -4-bit input port. <br> -CMOS compatible input level. <br> -Pull-down control is enabled. | -LCD segment output pins |

Table 2 Pin description (2)

| Pin | Name | Function | Function except a port function |
| :---: | :---: | :---: | :---: |
| P40 | Input port P4 | -1-bit Input port. <br> -CMOS compatible input level. |  |
| P41/ $\phi$ | I/O port P4 | -7-bit I/O port. <br> -CMOS compatible input level. <br> -CMOS 3-state output structure. <br> -I/O direction register allows each pin to be individually programmed as either input or output. <br> -Pull-up control is enabled. | - $\phi$ clock output pin |
| $\begin{aligned} & \text { P42/INT0, } \\ & \text { P43/INT1 } \\ & \hline \end{aligned}$ |  |  | $\bullet$ - Interrupt input pins |
| $\begin{aligned} & \text { P44/RxD, } \\ & \text { P45/TxD, } \\ & \text { P46/ScLK, } \\ & \text { P47/SRDY } \end{aligned}$ |  |  | - Serial I/O function pins |
| P50/INT2, P51/INT3 | I/O port P5 | -8-bit I/O port. <br> -CMOS compatible input level. <br> -CMOS 3-state output structure. <br> -I/O direction register allows each pin to be individually programmed as either input or output. <br> -Pull-up control is enabled. | - Interrupt input pins |
| $\begin{aligned} & \text { P52/RTP0, } \\ & \text { P53/RTP1 } \end{aligned}$ |  |  | -Real time port function pins |
| P54/CNTR0, P55/CNTR1 |  |  | - Timer $\mathrm{X}, \mathrm{Y}$ function pins |
| P56/TouT |  |  | - Timer 2 output pins |
| P57/ADT |  |  | -A-D trigger input pins |
| $\begin{aligned} & \hline \text { P60/AN0- } \\ & \text { P67/AN7 } \end{aligned}$ | I/O port P6 | -8-bit I/O port. <br> -CMOS compatible input level. <br> -CMOS 3-state output structure. <br> -I/O direction register allows each pin to be individually programmed as either input or output. <br> -Pull-up control is enabled. | -A-D conversion input pins |
| P7o/Xcout, <br> P71/XCIN | I/O port P7 | -2-bit I/O port. <br> -CMOS compatible input level. <br> -CMOS 3-state output structure. <br> -I/O direction register allows each pin to be individually programmed as either input or output. <br> -Pull-up control is enabled. | -Sub-clock generating circuit I/O pins. (Connect a resonator. External clock cannot be used.) |

## PART NUMBERING

Product

Fig. 4 Part numbering

## GROUP EXPANSION (STANDARD, ONE TIME PROM VERSION, EPROM VERSION)

Mitsubishi plans to expand the 3822 group (Standard, One Time PROM version, EPROM version) as follows:

## Memory Type

Support for Mask ROM, One Time PROM, and EPROM versions

## Memory Size

ROM size ......................................................... 8 K to 48 K bytes
RAM size 384 to 1024 bytes

## Package

80P6N-A ................................... 0.8 mm-pitch plastic molded QFP 80P6S-A ................................. 0.65 mm-pitch plastic molded QFP 80P6Q-A .................................. 0.5 mm -pitch plastic molded QFP 80D0 0.8 mm-pitch ceramic LCC (EPROM version)

## Memory Expansion Plan



Note: Products under development or planning: the development schedule and specifications may be revised without notice.

Fig. 5 Memory expansion plan
Currently products are listed below.
Table 3 List of products
As of Feb. 2002

| Product | ROM size (bytes) ROM size for User in ( ) | RAM size (bytes) | Package | Remarks |
| :---: | :---: | :---: | :---: | :---: |
| M38222M2-XXXFP | $\begin{gathered} 8192 \\ (8062) \end{gathered}$ | 384 | 80P6N-A | Mask ROM version |
| M38222M2-XXXGP |  |  | 80P6S-A | Mask ROM version |
| M38222M2-XXXHP |  |  | 80P6Q-A | Mask ROM version |
| M38223M4-XXXFP | $\begin{gathered} 16384 \\ (16254) \end{gathered}$ | 512 | 80P6N-A | Mask ROM version |
| M38223E4FP |  |  |  | One Time PROM version (blank) |
| M38223M4-XXXGP |  |  | 80P6S-A | Mask ROM version |
| M38223E4GP |  |  |  | One Time PROM version (blank) |
| M38223M4-XXXHP |  |  | 80P6Q-A | Mask ROM version |
| M38223E4HP |  |  |  | One Time PROM version (blank) |
| M38223E4FS |  |  | 80D0 | EPROM version |
| M38227ECFP | $\begin{gathered} 49152 \\ (49022) \end{gathered}$ | 1024 | 80P6N-A | One Time PROM version (blank) |
| M38227ECHP |  |  | 80P6Q-A | One Time PROM version (blank) |
| M38227ECFS |  |  | 80D0 | EPROM version |

## GROUP EXPANSION <br> (EXTENDED OPERATING TEMPERATURE VERSION)

Mitsubishi plans to expand the 3822 group (extended operating temperature version) as follows:

Memory Type
Support for Mask ROM version.

## Memory Size

ROM size ............................................................................................................................... 1024 bytes

## Package

80P6N-A

Memory Expansion Plan


Fig. 6 Memory expansion plan for extended operating temperature version

Currently products are listed below.

Table 4 List of products for extended operating temperature version As of Feb. 2002

| Product | ROM size (bytes) <br> ROM size for User in ( ) | RAM size (bytes) | Package | Remarks |
| :---: | :---: | :---: | :---: | :---: |
| M38227MCDXXXFP | $49152(49022)$ | 1024 | $80 P 6 N-A$ | Mask ROM version |

RenesasTechnologyCorp.

## GROUP EXPANSION (M VERSION)

Mitsubishi plans to expand the 3822 group ( M version) as follows:

## Memory Type

Support for Mask ROM version.

## Memory Size

ROM size
16 K to 24 K bytes
RAM size
512 to 640 bytes

## Package

80P6N-A ................................... 0.8 mm-pitch plastic molded QFP 80P6S-A .................................. 0.65 mm-pitch plastic molded QFP
80P6Q-A
.0 .5 mm -pitch plastic molded QFP

## Memory Expansion Plan



Fig. 7 Memory expansion plan for $M$ version

Currently products are listed below.
Table 5 List of products for $M$ version
As of Feb. 2002

| Product | ROM size (bytes) <br> ROM size for User in ( ) | RAM size (bytes) | Package | Remarks |
| :---: | :---: | :---: | :---: | :---: |
| M38223M4MXXXFP | $\begin{gathered} 16384 \\ (16254) \end{gathered}$ | 512 | 80P6N-A | Mask ROM version |
| M38223M4MXXXGP |  |  | 80P6S-A | Mask ROM version |
| M38223M4MXXXHP |  |  | 80P6Q-A | Mask ROM version |
| M38224M6MXXXFP | $\begin{gathered} 24576 \\ (24446) \end{gathered}$ | 640 | 80P6N-A | Mask ROM version |
| M38224M6MXXXHP |  |  | 80P6Q-A | Mask ROM version |

## GROUP EXPANSION (H VERSION)

Mitsubishi plans to expand the 3822 group (H version) as follows:

## Memory Type

Support for Mask ROM version.

## Memory Size

ROM size
16 K to 48 K bytes
RAM size
512 to 1024 bytes

## Package

80P6N-A ................................... 0.8 mm-pitch plastic molded QFP
80P6Q-A .................................... 0.5 mm-pitch plastic molded QFP

## Memory Expansion Plan



Fig. 8 Memory expansion plan for H version

Currently products are listed below.
Table 6 List of products for H version
As of Feb. 2002

| Product | ROM size (bytes) ROM size for User in ( ) | RAM size (bytes) | Package | Remarks |
| :---: | :---: | :---: | :---: | :---: |
| M38223M4HXXXFP | $\begin{gathered} 16384 \\ (16254) \end{gathered}$ | 512 | 80P6N-A | Mask ROM version |
| M38223M4HXXXHP |  |  | 80P6Q-A | Mask ROM version |
| M38224M6HXXXFP | $\begin{gathered} 24576 \\ (24446) \\ \hline \end{gathered}$ | 640 | 80P6N-A | Mask ROM version |
| M38224M6HXXXHP |  |  | 80P6Q-A | Mask ROM version |
| M38227M8HXXXFP | $\begin{gathered} 32768 \\ (32638) \end{gathered}$ | 1024 | 80P6N-A | Mask ROM version |
| M38227M8HXXXHP |  |  | 80P6Q-A | Mask ROM version |
| M38227MCHXXXFP | $\begin{gathered} 49152 \\ (49022) \end{gathered}$ |  | 80P6N-A | Mask ROM version |
| M38227MCHXXXHP |  |  | 80P6Q-A | Mask ROM version |

## FUNCTIONAL DESCRIPTION <br> CENTRAL PROCESSING UNIT (CPU)

The 3822 group uses the standard 740 family instruction set. Refer to the table of 740 family addressing modes and machine instructions or the 740 Family Software Manual for details on the instruction set.
Machine-resident 740 family instructions are as follows:
The FST and SLW instruction cannot be used.
The STP, WIT, MUL, and DIV instruction can be used.

## [Accumulator (A)]

The accumulator is an 8-bit register. Data operations such as data transfer, etc., are executed mainly through the accumulator.

## [Index Register X (X)]

The index register $X$ is an 8-bit register. In the index addressing modes, the value of the OPERAND is added to the contents of register X and specifies the real address.

## [Index Register Y (Y)]

The index register $Y$ is an 8-bit register. In partial instruction, the value of the OPERAND is added to the contents of register Y and specifies the real address.

## [Stack Pointer (S)]

The stack pointer is an 8-bit register used during subroutine calls and interrupts. This register indicates start address of stored area (stack) for storing registers during subroutine calls and interrupts. The low-order 8 bits of the stack address are determined by the contents of the stack pointer. The high-order 8 bits of the stack address are determined by the stack page selection bit. If the stack page selection bit is " 0 ", the high-order 8 bits becomes " 0016 ". If the stack page selection bit is " 1 ", the high-order 8 bits becomes "0116".
The operations of pushing register contents onto the stack and popping them from the stack are shown in Figure 10.
Store registers other than those described in Figure 10 with program when the user needs them during interrupts or subroutine calls.

## [Program Counter (PC)]

The program counter is a 16 -bit counter consisting of two 8-bit registers PCH and PCL. It is used to indicate the address of the next instruction to be executed.


Fig. 9740 Family CPU register structure


Fig. 10 Register push and pop at interrupt generation and subroutine call

Table 7 Push and pop instructions of accumulator or processor status register

|  | Push instruction to stack | Pop instruction from stack |
| :--- | :---: | :---: |
| Accumulator | PHA | PLA |
| Processor status register | PHP | PLP |

## [Processor status register (PS)]

The processor status register is an 8-bit register consisting of 5 flags which indicate the status of the processor after an arithmetic operation and 3 flags which decide MCU operation. Branch operations can be performed by testing the Carry (C) flag, Zero (Z) flag, Overflow (V) flag, or the Negative (N) flag. In decimal mode, the Z, V , N flags are not valid.
-Bit 0: Carry flag (C)
The C flag contains a carry or borrow generated by the arithmetic logic unit (ALU) immediately after an arithmetic operation. It can also be changed by a shift or rotate instruction.
-Bit 1: Zero flag (Z)
The $Z$ flag is set if the result of an immediate arithmetic operation or a data transfer is " 0 ", and cleared if the result is anything other than "0".
-Bit 2: Interrupt disable flag (I)
The I flag disables all interrupts except for the interrupt generated by the BRK instruction.
Interrupts are disabled when the I flag is " 1 ".
-Bit 3: Decimal mode flag (D)
The D flag determines whether additions and subtractions are executed in binary or decimal. Binary arithmetic is executed when this flag is " 0 "; decimal arithmetic is executed when it is " 1 ". Decimal correction is automatic in decimal mode. Only the ADC and SBC instructions can be used for decimal arithmetic.
-Bit 4: Break flag (B)
The B flag is used to indicate that the current interrupt was generated by the BRK instruction. The BRK flag in the processor status register is always " 0 ". When the BRK instruction is used to generate an interrupt, the processor status register is pushed onto the stack with the break flag set to " 1 ".
-Bit 5: Index X mode flag (T)
When the T flag is " 0 ", arithmetic operations are performed between accumulator and memory. When the $T$ flag is " 1 ", direct arithmetic operations and direct data transfers are enabled between memory locations.
-Bit 6: Overflow flag (V)
The $V$ flag is used during the addition or subtraction of one byte of signed data. It is set if the result exceeds +127 to -128 . When the BIT instruction is executed, bit 6 of the memory location operated on by the BIT instruction is stored in the overflow flag.
-Bit 7: Negative flag ( N )
The N flag is set if the result of an arithmetic operation or data transfer is negative. When the BIT instruction is executed, bit 7 of the memory location operated on by the BIT instruction is stored in the negative flag.

Table 8 Set and clear instructions of each bit of processor status register

|  | C flag | Z flag | I flag | D flag | B flag | T flag | V flag | N flag |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Set instruction | SEC | - | SEI | SED | - | SET | - | - |
| Clear instruction | CLC | - | CLI | CLD | - | CLT | CLV | - |

## [CPU Mode Register (CPUM)] 003B16

The CPU mode register contains the stack page selection bit and the internal system clock selection bit.
The CPU mode register is allocated at address 003B16.


Fig. 11 Structure of CPU mode register

## MEMORY

## Special Function Register (SFR) Area

The Special Function Register area in the zero page contains control registers such as I/O ports and timers.

## RAM

RAM is used for data storage and for stack area of subroutine calls and interrupts.

## ROM

The first 128 bytes and the last 2 bytes of ROM are reserved for device testing and the rest is user area for storing programs.

## Interrupt Vector Area

The interrupt vector area contains reset and interrupt vectors.

## Zero Page

The 256 bytes from addresses 000016 to 00FF 16 are called the zero page area. The internal RAM and the special function register (SFR) are allocated to this area.
The zero page addressing mode can be used to specify memory and register addresses in the zero page area. Access to this area with only 2 bytes is possible in the zero page addressing mode.

## Special Page

The 256 bytes from addresses FF0016 to FFFF16 are called the special page area. The special page addressing mode can be used to specify memory addresses in the special page area. Access to this area with only 2 bytes is possible in the special page addressing mode.

## RAM area

| RAM size <br> (bytes) | Address <br> XXXX $_{16}$ |
| :---: | :---: |
| 192 | 00FF $_{16}$ |
| 256 | $0^{013 F_{16}}$ |
| 384 | $0^{01 B F_{16}}$ |
| 512 | $0^{023 F_{16}}$ |
| 640 | $0^{02 F_{16}}$ |
| 768 | $0^{033 F_{16}}$ |
| 896 | $03 \mathrm{BF}_{16}$ |
| 1024 | $043 F_{16}$ |

ROM area

| ROM size <br> (bytes) | Address <br> YYYY16 | Address <br> ZZZZ16 |
| :---: | :---: | :---: |
| 4096 | F00016 | F08016 |
| 8192 | E00016 | E08016 |
| 12288 | D00016 | D08016 |
| 16384 | C00016 | C08016 |
| 20480 | B00016 | B08016 |
| 24576 | A00016 | A08016 |
| 28672 | 900016 | 908016 |
| 32768 | 800016 | 808016 |
| 36864 | 700016 | 708016 |
| 40960 | 600016 | 608016 |
| 45056 | 500016 | 508016 |
| 49152 | 400016 | 408016 |

Fig. 12 Memory map diagram

| 000016 | Port P0 (P0) | Timer X (low) (TXL) |
| :---: | :---: | :---: |
| 000116 | Port P0 direction register (POD) | Timer X (high) (TXH) |
| 000216 | Port P1 (P1) | Timer Y (low) (TYL) |
| 000316 | Port P1 output control register (P1D) | Timer Y (high) (TYH) |
| 000416 | Port P2 (P2) | Timer 1 (T1) |
| 000516 | Port P2 direction register (P2D) | Timer 2 (T2) |
| 000616 | Port P3 (P3) | Timer 3 (T3) |
| 000716 |  | Timer X mode register (TXM) |
| 000816 | Port P4 (P4) | Timer Y mode register (TYM) |
| 000916 | Port P4 direction register (P4D) | Timer 123 mode register (T123M) |
| 000A ${ }_{16}$ | Port P5 (P5) | $\phi$ output control register (CKOUT) |
| 000B16 | Port P5 direction register (P5D) |  |
| $000 \mathrm{C}_{16}$ | Port P6 (P6) |  |
| 000D 16 | Port P6 direction register (P6D) |  |
| 000E 16 | Port P7 (P7) |  |
| 000F16 | Port P7 direction register (P7D) |  |
| 001016 |  |  |
| 001116 |  |  |
| 001216 |  |  |
| 001316 |  |  |
| 001416 |  | A-D control register (ADCON) |
| 001516 |  | A-D conversion register (AD) |
| 001616 | PULL register A (PULLA) |  |
| 001716 | PULL register B (PULLB) |  |
| 001816 | Transmit/Receive buffer register (TB/RB) | Segment output enable register (SEG) |
| 001916 | Serial I/O status register (SIOSTS) | LCD mode register (LM) |
| 001A ${ }_{16}$ | Serial I/O control register (SIO1CON) | Interrupt edge selection register (INTEDGE) |
| 001B16 | UART control register (UARTCON) | CPU mode register (CPUM) |
| $001 \mathrm{C}_{16}$ | Baud rate generator (BRG) | Interrupt request register 1(IREQ1) |
| 001D16 |  | Interrupt request register 2(IREQ2) |
| 001E ${ }_{16}$ |  | Interrupt control register 1(ICON1) |
| 001F16 |  | Interrupt control register 2(ICON2) |

Fig. 13 Memory map of special function register (SFR)

## I/O PORTS <br> Direction Registers (ports P2, P41-P47, and P5-P7)

The 3822 group has 49 programmable I/O pins arranged in seven I/O ports (ports P0-P2, P41-P47 and P5-P7). The I/O ports P2, $\mathrm{P} 41-\mathrm{P} 47$ and P5-P7 have direction registers which determine the input/output direction of each individual pin. Each bit in a direction register corresponds to one pin, and each pin can be set to be input port or output port.
When " 0 " is written to the bit corresponding to a pin, that pin becomes an input pin. When " 1 " is written to that bit, that pin becomes an output pin.
If data is read from a pin set to output, the value of the port output latch is read, not the value of the pin itself. Pins set to input are floating. If a pin set to input is written to, only the port output latch is written to and the pin remains floating.

## Direction Registers (ports P0 and P1)

Ports P0 and P1 have direction registers which determine the input/output direction of each individual port.
Each port in a direction register corresponds to one port, each port can be set to be input or output. When " 0 " is written to the bit 0 of a direction register, that port becomes an input port. When " 1 " is written to that port, that port becomes an output port. Bits 1 to 7 of ports P0 and P1 direction registers are not used.

## Ports P3 and P4o

These ports are only for input.

## Pull-up/Pull-down Control

By setting the PULL register A (address 001616) or the PULL register B (address 001716), ports except for port P4o can control either pull-down or pull-up (pins that are shared with the segment output pins for LCD are pull-down; all other pins are pull-up) with a program.
However, the contents of PULL register A and PULL register B do not affect ports programmed as the output ports.


> 0: Disable
> 1: Enable

Note: The contents of PULL register A and PULL register B do not affect ports programmed as the output port.

Fig. 14 Structure of PULL register A and PULL register B

Table 9 List of I/O port function

| Pin | Name | Input/Output | I/O Format | Non-Port Function | Related SFRs | Diagram No. |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\begin{aligned} & \text { P00/SEG16- } \\ & \text { P07/SEG23 } \end{aligned}$ | Port P0 | Input/output, individual ports | CMOS compatible input level CMOS 3-state output | LCD segment output | PULL register A <br> Segment output enable register | (1) |
| $\begin{aligned} & \text { P10/SEG24- } \\ & \text { P17/SEG31 } \end{aligned}$ | Port P1 |  |  |  |  |  |
| P20-P27 | Port P2 | Input/output, individual bits | CMOS compatible input level CMOS 3-state output | Key input (key-on wake-up) interrupt input | PULL register A Interrupt control register 2 | (2) |
| P34/SEG12P37/SEG15 | Port P3 | Input | CMOS compatible input level | LCD segment output | PULL register A <br> Segment output enable register | (3) |
| P40 | Port P4 | Input | CMOS compatible input level |  |  | (4) |
| P41/ ¢ |  | Input/output, individual bits | CMOS compatible input level CMOS 3-state output | $\phi$ clock output | PULL register B <br> ф output control register | (5) |
| $\begin{aligned} & \mathrm{P} 42 / \mathrm{INT} 0, \\ & \mathrm{P} 43 / \mathrm{INT} 1 \end{aligned}$ |  |  |  | External interrupt input | PULL register B <br> Interrupt edge selection register | (2) |
| P44/RxD |  |  |  | Serial I/O function I/O | PULL register B <br> Serial I/O control register <br> Serial I/O status register <br> UART control register | (6) |
| P45/TxD |  |  |  |  |  | (7) |
| P46/ScLK |  |  |  |  |  | (8) |
| P47/SRDY |  |  |  |  |  | (9) |
| P50/INT2, P51/INT3 | Port P5 | Input/output, individual bits | CMOS compatible input level CMOS 3-state output | External interrupt input | PULL register B <br> Interrupt edge selection register | (2) |
| $\begin{aligned} & \text { P52/RTP0, } \\ & \text { P53/RTP1 } \end{aligned}$ |  |  |  | Real time port function output | PULL register B Timer X mode register | (10) |
| P54/CNTR0 |  |  |  | Timer X function I/O | PULL register B Timer X mode register | (11) |
| P55/CNTR1 |  |  |  | Timer Y function input | PULL register B Timer Y mode register | (12) |
| P56/TouT |  |  |  | Timer 2 function output | PULL register B <br> Timer 123 mode register | (13) |
| P57/ADT |  |  |  | A-D trigger input | PULL register B A-D control register | (12) |
| $\begin{aligned} & \text { P60/AN0- } \\ & \text { P67/AN7 } \end{aligned}$ | Port P6 | Input/output, individual bits | CMOS compatible input level CMOS 3-state output | A-D conversion input |  | (14) |
| P70/Xcout | Port P7 | Input/output, individual bits | CMOS compatible input level CMOS 3-state output | Sub-clock generating circuit I/O | PULL register A CPU mode register | (15) |
| P71/XCIN |  |  |  |  |  | (16) |
| COM0-COM3 | Common | Output | LCD common output |  | LCD mode register | (17) |
| SEG0-SEG11 | Segment | Output | LCD segment output |  |  | (18) |

Notes1: How to use double-function ports as function I/O ports, refer to the applicable sections.
2: Make sure that the input level at each pin is either 0 V or VCC during execution of the STP instruction. When an input level is at an intermediate potential, a current will flow Vcc to Vss through the input-stage gate.

(2) Ports P2, P42, P43, P50, P51


Note: Bit 0 of direction register.


Fig. 15 Port block diagram (1)


Fig. 16 Port block diagram (2)

RenesasTechnology Corp.
(13) Port P56

(14) Port P6

(15) Port P7o

(16) Port P71

(18) SEG0-SEG ${ }_{11}$


Fig. 17 Port block diagram (3)

## INTERRUPTS

Interrupts occur by seventeen sources: eight external, eight internal, and one software.

## Interrupt Control

Each interrupt is controlled by an interrupt request bit, an interrupt enable bit, and the interrupt disable flag except for the software interrupt set by the BRK instruction. An interrupt occurs if the corresponding interrupt request and enable bits are "1" and the interrupt disable flag is " 0 ".
Interrupt enable bits can be set or cleared by software.
Interrupt request bits can be cleared by software, but cannot be set by software.
The BRK instruction cannot be disabled with any flag or bit. The I flag disables all interrupts except the BRK instruction interrupt.
When several interrupts occur at the same time, the interrupts are received according to priority.

## Interrupt Operation

Upon acceptance of an interrupt the following operations are automatically performed:

1. The contents of the program counter and processor status register are automatically pushed onto the stack.
2. The interrupt disable flag is set and the corresponding interrupt request bit is cleared.
3. The interrupt jump destination address is read from the vector table into the program counter.

## -Notes on interrupts

When setting the followings, the interrupt request bit may be set to "1".
-When setting external interrupt active edge
Related register: Interrupt edge selection register (address 3A16) Timer X mode register (address 2716) Timer Y mode register (address 2816)
-When switching interrupt sources of an interrupt vector address where two or more interrupt sources are allocated
Related register: A-D control regsiter (address 3416)
When not requiring for the interrupt occurrence synchronized with these setting, take the following sequence.
(1)Set the corresponding interrupt enable bit to "0" (disabled).
(2)Set the interrupt edge select bit or the interrupt source select bit to " 1 ".
(3)Set the corresponding interrupt request bit to "0" after 1 or more instructions have been executed.
(4)Set the corresponding interrupt enable bit to "1" (enabled).

Table 10 Interrupt vector addresses and priority

| Interrupt Source | Priority | Vector Addresses (Note 1) |  | Interrupt Request <br> Generating Conditions |  |
| :--- | :---: | :---: | :---: | :--- | :--- |
|  |  | High | Low | Remarks |  |

[^0]

Fig. 18 Interrupt control


Fig. 19 Structure of interrupt-related registers

## Key Input Interrupt (Key-on wake-up)

A Key-on wake-up interrupt request is generated by applying a falling edge to any pin of port P2 that have been set to input mode. In other words, it is generated when AND of input level goes from
" 1 " to " 0 ". An example of using a key input interrupt is shown in Figure 20, where an interrupt request is generated by pressing one of the keys consisted as an active-low key matrix which inputs to ports P20-P23.


Fig. 20 Connection example when using key input interrupt and port P2 block diagram

## TIMERS

The 3822 group has five timers: timer X , timer Y , timer 1, timer 2, and timer 3. Timer $X$ and timer $Y$ are 16-bit timers, and timer 1, timer 2, and timer 3 are 8-bit timers.
All timers are down count timers. When the timer reaches " 0016 ", an underflow occurs at the next count pulse and the corresponding timer latch is reloaded into the timer and the count is continued. When a timer underflows, the interrupt request bit cor-
responding to that timer is set to " 1 ".
Read and write operation on 16-bit timer must be performed for both high and low-order bytes. When reading a 16-bit timer, read the high-order byte first. When writing to a 16-bit timer, write the low-order byte first. The 16-bit timer cannot perform the correct operation when reading during the write operation, or when writing during the read operation.


Fig. 21 Timer block diagram

## Timer X

Timer $X$ is a 16-bit timer that can be selected in one of four modes and can be controlled the timer $X$ write and the real time port by setting the timer X mode register.

## (1) Timer Mode

The timer counts $f(X I N) / 16$ (or $f(X C I N) / 16$ in low-speed mode).

## (2) Pulse Output Mode

Each time the timer underflows, a signal output from the CNTRo pin is inverted. Except for this, the operation in pulse output mode is the same as in timer mode. When using a timer in this mode, set the corresponding port P54 direction register to output mode.

## (3) Event Counter Mode

The timer counts signals input through the CNTRo pin.
Except for this, the operation in event counter mode is the same as in timer mode. When using a timer in this mode, set the corresponding port P54 direction register to input mode.

## (4) Pulse Width Measurement Mode

The count source is $f(X I N) / 16$ (or $f\left(X_{C I N}\right) / 16$ in low-speed mode). If CNTR 0 active edge switch bit is " 0 ", the timer counts while the input signal of CNTRo pin is at " H ". If it is " 1 ", the timer counts while the input signal of CNTRo pin is at " L ". When using a timer in this mode, set the corresponding port P54 direction register to input mode.

## -Timer X write control

If the timer X write control bit is " 0 ", when the value is written in the address of timer X , the value is loaded in the timer X and the latch at the same time.
If the timer X write control bit is " 1 ", when the value is written in the address of timer $X$, the value is loaded only in the latch. The value in the latch is loaded in timer $X$ after timer $X$ underflows.
If the value is written in latch only, when writing in the timer latch at the timer underflow, the value is set in the timer and the latch at one time. Additionally, unexpected value may be set in the high-order counter when the writing in high-order latch and the underflow of timer X are performed at the same timing.

## -Real time port control

While the real time port function is valid, data for the real time port are output from ports P52 and P53 each time the timer $X$ underflows. (However, after rewriting a data for real time port, if the real time port control bit is changed from " 0 " to " 1 ", data are output independent of the timer X operation.) If the data for the real time port is changed while the real time port function is valid, the changed data are output at the next underflow of timer X .
Before using this function, set the corresponding port direction registers to output mode.

## ■Note on CNTRo interrupt active edge selection

CNTRo interrupt active edge depends on the CNTRo active edge switch bit.


Fig. 22 Structure of timer X mode register

## Timer Y

Timer Y is a 16-bit timer that can be selected in one of four modes.

## (1) Timer Mode

The timer counts $f(X I N) / 16$ (or $f(X C I N) / 16$ in low-speed mode).

## (2) Period Measurement Mode

CNTR1 interrupt request is generated at rising/falling edge of CNTR1 pin input signal. Simultaneously, the value in timer $Y$ latch is reloaded in timer Y and timer Y continues counting down. Except for the above-mentioned, the operation in period measurement mode is the same as in timer mode.
The timer value just before the reloading at rising/falling of CNTR1 pin input signal is retained until the timer $Y$ is read once after the reload.
The rising/falling timing of CNTR1 pin input signal is found by CNTR1 interrupt. When using a timer in this mode, set the corresponding port P55 direction register to input mode.

## (3) Event Counter Mode

The timer counts signals input through the CNTR1 pin.
Except for this, the operation in event counter mode is the same as in timer mode. When using a timer in this mode, set the corresponding port P55 direction register to input mode.

## (4) Pulse Width HL Continuously Measurement Mode

CNTR1 interrupt request is generated at both rising and falling edges of CNTR1 pin input signal. Except for this, the operation in pulse width HL continuously measurement mode is the same as in period measurement mode. When using a timer in this mode, set the corresponding port P55 direction register to input mode.

## - Note on CNTR1 interrupt active edge selection

CNTR1 interrupt active edge depends on the CNTR1 active edge switch bit. However, in pulse width HL continuously measurement mode, CNTR1 interrupt request is generated at both rising and falling edges of CNTR1 pin input signal regardless of the setting of CNTR1 active edge switch bit.


Fig. 23 Structure of timer Y mode register

## Timer 1, Timer 2, Timer 3

Timer 1, timer 2, and timer 3 are 8 -bit timers. The count source for each timer can be selected by timer 123 mode register. The timer latch value is not affected by a change of the count source. However, because changing the count source may cause an inadvertent count down of the timer, rewrite the value of timer whenever the count source is changed.

## -Timer 2 write control

If the timer 2 write control bit is " 0 ", when the value is written in the address of timer 2, the value is loaded in the timer 2 and the latch at the same time.
If the timer 2 write control bit is " 1 ", when the value is written in the address of timer 2 , the value is loaded only in the latch. The value in the latch is loaded in timer 2 after timer 2 underflows.

## -Timer 2 output control

When the timer 2 (TOUT) is output enabled, an inversion signal from the Tout pin is output each time timer 2 underflows.
In this case, set the port shared with the Tout pin to the output mode.

## -Notes on timer 1 to timer 3

When the count source of timer 1 to 3 is changed, the timer counting value may be changed large because a thin pulse is generated in count input of timer. If timer 1 output is selected as the count source of timer 2 or timer 3 , when timer 1 is written, the counting value of timer 2 or timer 3 may be changed large because a thin pulse is generated in timer 1 output.
Therefore, set the value of timer in the order of timer 1 , timer 2 and timer 3 after the count source selection of timer 1 to 3 .


Fig. 24 Structure of timer 123 mode register

## SERIAL I/O

Serial I/O can be used as either clock synchronous or asynchronous (UART) serial I/O. A dedicated timer (baud rate generator) is also provided for baud rate generation.

## (1) Clock Synchronous Serial I/O Mode

Clock synchronous serial I/O can be selected by setting the mode selection bit of the serial I/O control register to " 1 ".
For clock synchronous serial I/O, the transmitter and the receiver must use the same clock. If an internal clock is used, transfer is started by a write signal to the transmit/receive buffer register.


Fig. 25 Block diagram of clock synchronous serial I/O


Fig. 26 Operation of clock synchronous serial I/O function

## (2) Asynchronous Serial I/O (UART) Mode

Clock asynchronous serial I/O mode (UART) can be selected by clearing the serial I/O mode selection bit of the serial I/O control register to " 0 ".
Eight serial data transfer formats can be selected, and the transfer formats used by a transmitter and receiver must be identical.
The transmit and receive shift registers each have a buffer regis-
ter, but the two buffers have the same address in memory. Since the shift register cannot be written to or read from directly, transmit data is written to the transmit buffer, and receive data is read from the receive buffer.
The transmit buffer can also hold the next data to be transmitted, and the receive buffer register can hold a character while the next character is being received.


Fig. 27 Block diagram of UART serial I/O


Fig. 28 Operation of UART serial I/O function

## [Transmit Buffer/Receive Buffer Register (TB/RB)] 001816

The transmit buffer register and the receive buffer register are located at the same address. The transmit buffer register is write-only and the receive buffer register is read-only. If a character bit length is 7 bits, the MSB of data stored in the receive buffer register is " 0 ".

## [Serial I/O Status Register (SIOSTS)] 001916

The read-only serial I/O status register consists of seven flags (bits 0 to 6 ) which indicate the operating status of the serial I/O function and various errors.
Three of the flags (bits 4 to 6 ) are valid only in UART mode.
The receive buffer full flag (bit 1 ) is cleared to " 0 " when the receive buffer is read.
If there is an error, it is detected at the same time that data is transferred from the receive shift register to the receive buffer register, and the receive buffer full flag is set. A write to the serial I/O status register clears all the error flags OE, PE, FE, and SE. Writing "0" to the serial I/O enable bit (SIOE) also clears all the status flags, including the error flags.
All bits of the serial I/O status register are initialized to " 0 " at reset, but if the transmit enable bit (bit 4) of the serial I/O control register has been set to "1", the transmit shift register shift completion flag (bit 2) and the transmit buffer empty flag (bit 0) become " 1 ".
[Serial I/O Control Register (SIOCON)] 001A16
The serial I/O control register contains eight control bits for the serial I/O function.

## [UART Control Register (UARTCON) ]001B16

The UART control register consists of four control bits (bits 0 to 3 ) which are valid when asynchronous serial I/O is selected and set the data format of an data transfer. One bit in this register (bit 4) is always valid and sets the output structure of the $\mathrm{P} 45 / \mathrm{T} \times \mathrm{D}$ pin.

## [Baud Rate Generator (BRG)] 001C16

The baud rate generator determines the baud rate for serial transfer.
The baud rate generator divides the frequency of the count source by $1 /(n+1)$, where $n$ is the value written to the baud rate generator.

## ■Notes on serial I/O

When setting the transmit enable bit to " 1 ", the serial I/O transmit interrupt request bit is automatically set to " 1 ". When not requiring the interrupt occurrence synchronized with the transmission enalbed, take the following sequence.
(1)Set the serial I/O transmit interrupt enable bit to " 0 " (disabled).
(2) Set the transmit enable bit to " 1 ".
(3) Set the serial I/O transmit interrupt request bit to "0" after 1 or more instructions have been executed.
(4)Set the serial I/O transmit interrupt enable bit to "1" (enabled).


1: $\mathrm{f}(\mathrm{XIN}) / 4\left(\mathrm{f}\left(\mathrm{XCIN}^{\prime}\right) / 4\right.$ in low-speed mode)
Serial I/O synchronization clock selection bit (SCS)
0 : BRG output divided by 4 when clock synchronized serial I/O is selected.
BRG output divided by 16 when UART is selected.
1: External clock input when clock synchronized serial I/O is selected.
External clock input divided by 16 when UART is selected.
$\overline{\text { SRDY output enable bit (SRDY) }}$
0 : P47 pin operates as ordinary I/O pin
1: P47 pin operates as $\overline{\text { SrDy }}$ output pin
Transmit interrupt source selection bit (TIC)
0 : Interrupt when transmit buffer has emptied
1: Interrupt when transmit shift operation is completed
Transmit enable bit (TE)
0 : Transmit disabled
1: Transmit enabled
Receive enable bit (RE)
0 : Receive disabled
1: Receive enabled
Serial I/O mode selection bit (SIOM)
0 : Asynchronous serial I/O (UART)
1: Clock synchronous serial I/O
Serial I/O enable bit (SIOE)
0 : Serial I/O disabled
(pins P44-P47 operate as ordinary I/O pins)
1: Serial I/O enabled
(pins P44-P47 operate as serial I/O pins)

Fig. 29 Structure of serial I/O control registers

## A-D CONVERTER [A-D Conversion Register (AD)] 003516

The A-D conversion register is a read-only register that contains the result of an A-D conversion. When reading this register during an A-D conversion, the previous conversion result is read.

## [A-D Control Register (ADCON)] 003416

The A-D control register controls the A-D conversion process. Bits 0 to 2 of this register select specific analog input pins. Bit 3 signals the completion of an A-D conversion. The value of this bit remains at " 0 " during an A-D conversion, then changes to " 1 " when the $A$ $D$ conversion is completed. Writing " 0 " to this bit starts the A-D conversion. Bit 4 controls the transistor which breaks the through current of the resistor ladder. When bit 5 , which is the AD external trigger valid bit, is set to " 1 ", this bit enables A-D conversion even by a falling edge of an ADT input. Set ports which share with ADT pins to input when using an A-D external trigger.

## [Comparison Voltage Generator]

The comparison voltage generator divides the voltage between AVSS and VREF by 256, and outputs the divided voltages.

## [Channel Selector]

The channel selector selects one of the input ports P67/AN7-P60/ ANo, and inputs it to the comparator.

## [Comparator and Control Circuit]

The comparator and control circuit compares an analog input voltage with the comparison voltage and stores the result in the A-D conversion register. When an A-D conversion is completed, the control circuit sets the AD conversion completion bit and the AD interrupt request bit to " 1 ".
Note that the comparator is constructed linked to a capacitor, so set $f($ XIN $)$ to at least 500 kHz during A-D conversion.
Use the clock divided from the main clock XIN as the internal clock $\phi$.


Fig. 30 Structure of A-D control register


Fig. 31 A-D converter block diagram

## LCD DRIVE CONTROL CIRCUIT

The 3822 group has the built-in Liquid Crystal Display (LCD) drive control circuit consisting of the following.

- LCD display RAM
- Segment output enable register
- LCD mode register
- Selector
- Timing controller
- Common driver
- Segment driver
- Bias control circuit

A maximum of 32 segment output pins and 4 common output pins can be used.
Up to 128 pixels can be controlled for LCD display. When the LCD
enable bit is set to " 1 " after data is set in the LCD mode register, the segment output enable register and the LCD display RAM, the LCD drive control circuit starts reading the display data automatically, performs the bias control and the duty ratio control, and displays the data on the LCD panel.

Table 11 Maximum number of display pixels at each duty ratio

| Duty ratio | Maximum number of display pixel |
| :---: | :--- |
| 2 | 64 dots <br> or 8 segment LCD 8 digits |
| 3 | 96 dots <br> or 8 segment LCD 12 digits |
| 4 | 128 dots <br> or 8 segment LCD 16 digits |



Segment output enable register (SEG : address 003816)

Segment output enable bit 0 0 : Input port P34-P37
1 : Segment output SEG ${ }_{12}$-SEG ${ }_{15}$
Segment output enable bit 1
0 : I/O port $\mathrm{P} 00, \mathrm{P} 0_{1}$
1 : Segment output SEG16, SEG17
Segment output enable bit 2
0 : I/O port PO2-PO7
1 : Segment output SEG 18 -SEG 23
Segment output enable bit 3
0 : I/O port P10, P1
1 : Segment output SEG24, SEG25
Segment output enable bit 4
0 : I/O port P12
1 : Segment output SEG26
Segment output enable bit 5
0 : I/O port $\mathrm{P}_{13}-\mathrm{P} 17$
1 : Segment output SEG27-SEG31
Not used (returns " 0 " when read)
(Do not write " 1 " to this bit.)


LCD mode register
(LM : address 003916)
Duty ratio selection bits
00 : Not used
$01: 2$ (use COM0, COM1)
$10: 3$ (use COM0-COM2)
11 : 4 (use COMo-COMз)
Bias control bit
$0: 1 / 3$ bias
$1: 1 / 2$ bias
LCD enable bit
0 : LCD OFF
1: LCD ON
Not used (returns " 0 " when read)
(Do not write " 1 " to this bit)
LCD circuit divider division ratio selection bits
00 : Clock input
01 : 2 division of clock input
10:4 division of clock input
11:8 division of clock input
LCDCK count source selection bit (Note)
$0: f(X$ CIN $) / 32$
1 : $f($ XIN $) / 8192$ (or $f\left(X_{\text {CIN }}\right) / 8192$ in low-speed mode)

Note: LCDCK is a clock for a LCD timing controller.

Fig. 32 Structure of segment output enable register and LCD mode register


Fig. 33 Block diagram of LCD controller/driver

## Bias Control and Applied Voltage to LCD Power Input Pins

To the LCD power input pins (VL1-VL3), apply the voltage shown in Table 12 according to the bias value.
Select a bias value by the bias control bit (bit 2 of the LCD mode register).

## Common Pin and Duty Ratio Control

The common pins (COM0-COM3) to be used are determined by duty ratio.
Select duty ratio by the duty ratio selection bits (bits 0 and 1 of the LCD mode register).

Table 12 Bias control and applied voltage to VL1-VL3

| Bias value | Voltage value |
| :---: | :---: |
| 1/3 bias | $\begin{aligned} & \hline \text { VL3 }=\text { VLCD } \\ & \text { VL2 }=2 / 3 \mathrm{VLCD} \\ & \mathrm{VL1}=1 / 3 \mathrm{VLCD} \end{aligned}$ |
| 1/2 bias | $\begin{aligned} & \mathrm{VL3}=\mathrm{VLCD} \\ & \mathrm{VL2}=\mathrm{VL} 1=1 / 2 \mathrm{VLCD} \end{aligned}$ |

Note 1: VLCD is the maximum value of supplied voltage for the LCD panel.

Table 13 Duty ratio control and common pins used

| Duty <br> ratio | Duty ratio selection bit |  | Common pins used |
| :---: | :---: | :---: | :--- |
|  | Bit 1 | Bit 0 |  |
| 2 | 0 | 1 | COM0, COM1 (Note 1) |
| 3 | 1 | 0 | $\mathrm{COM} 0-\mathrm{COM} 2$ (Note 2) |
| 4 | 1 | 1 | $\mathrm{COM} 0-\mathrm{COM} 3$ |

Notes1: COM2 and COM3 are open.
2: $\mathrm{COM}_{3}$ is open.


Fig. 34 Example of circuit at each bias

## LCD Display RAM

Address 004016 to 004F16 is the designated RAM for the LCD display. When " 1 " are written to these addresses, the corresponding segments of the LCD display panel are turned on.

## LCD Drive Timing

The LCDCK timing frequency (LCD drive timing) is generated internally and the frame frequency can be determined with the following equation;

$$
\begin{aligned}
& f(\text { LCDCK })=\frac{\text { (frequency of count source for LCDCK) }}{\text { (divider division ratio for LCD) }} \\
& \text { Frame frequency }=\frac{f(\text { LCDCK })}{\text { (duty ratio) }}
\end{aligned}
$$

|  | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 004016 | SEG1 |  |  |  | SEG0 |  |  |  |
| 004116 | SEG3 |  |  |  | SEG2 |  |  |  |
| 004216 | SEG5 |  |  |  | SEG4 |  |  |  |
| 004316 | SEG7 |  |  |  | SEG6 |  |  |  |
| 004416 | SEG9 |  |  |  | SEG8 |  |  |  |
| 004516 | SEG11 |  |  |  | SEG10 |  |  |  |
| 004616 | SEG13 |  |  |  | SEG12 |  |  |  |
| 004716 | SEG15 |  |  |  | SEG14 |  |  |  |
| 004816 | SEG17 |  |  |  | SEG16 |  |  |  |
| 004916 | SEG19 |  |  |  | SEG18 |  |  |  |
| 004A16 | SEG21 |  |  |  | SEG20 |  |  |  |
| 004B16 | SEG23 |  |  |  | SEG22 |  |  |  |
| 004C16 | SEG25 |  |  |  | SEG24 |  |  |  |
| 004D16 | SEG27 |  |  |  | SEG26 |  |  |  |
| 004E16 | SEG29 |  |  |  | SEG28 |  |  |  |
| 004F16 | SEG31 |  |  |  | SEG30 |  |  |  |
|  | COM3 | COM2 | COM1 | COM0 | COM3 | COM2 | COM1 | COM0 |

Fig. 35 LCD display RAM map


Fig. 36 LCD drive waveform (1/2 bias)


Fig. 37 LCD drive waveform (1/3 bias)

## $\phi$ CLOCK SYSTEM OUTPUT FUNCTION

The internal system clock $\phi$ can be output from port P41 by setting the $\phi$ output control register. Set bit 1 of the port P4 direction register to "1" when outputting $\phi$ clock.


Fig. 38 Structure of $\phi$ output control register

## RESET CIRCUIT

To reset the microcomputer, $\overline{\text { RESET }}$ pin should be held at an " L " level for $2 \mu \mathrm{~s}$ or more. Then the $\overline{\text { RESET }}$ pin is returned to an " H " level (the power source voltage should be between Vcc(min.) and 5.5 V , and the quartz-crystal oscillator should be stable), reset is released. After the reset is completed, the program starts from the address contained in address FFFD16 (high-order byte) and address FFFC16 (low-order byte). Make sure that the reset input voltage meets VIL spec. when a power source voltage passes $\operatorname{Vcc}(m i n$.$) .$


Fig. 39 Reset Circuit Example


Fig. 40 Reset Sequence

|  |  | Address | Register Contents |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| (1) | Port P0 direction register | 000116 | 0016 |  |  |  |  |  |
| (2) | Port P1 direction register | 000316 | 0016 |  |  |  |  |  |
| (3) | Port P2 direction register | 000516 | 0016 |  |  |  |  |  |
| (4) | Port P4 direction register | 000916 | 0016 |  |  |  |  |  |
| (5) | Port P5 direction register | 000B16 | 0016 |  |  |  |  |  |
| (6) | Port P6 direction register | 000D16 | 0016 |  |  |  |  |  |
| (7) | Port P7 direction register | 000F16 | 0016 |  |  |  |  |  |
| (8) | PULL register A | 001616 | 0 | 0 | $0 \mid 1$ | 0 | 1 | 1 |
| (9) | PULL register B | 001716 | 0016 |  |  |  |  |  |
| (10) | Sirial I/O status register | 001916 | $1{ }^{1} 10$ | 0 | 0 | 0 | 0 | 0 |
| (11) | Sirial I/O control register | 001A16 | 0016 |  |  |  |  |  |
| (12) | UART control register | 001B16 | 111 | 1 | 0 10 | 0 | 0 | 0 |
| (13) | Timer X(Low) | 002016 | FF16 |  |  |  |  |  |
| (14) | Timer X(High) | 002116 | FF16 |  |  |  |  |  |
| (15) | Timer Y(Low) | 002216 | FF16 |  |  |  |  |  |
| (16) | Timer Y(High) | 002316 | FF16 |  |  |  |  |  |
| (17) | Timer 1 | 002416 | FF16 |  |  |  |  |  |
| (18) | Timer 2 | 002516 | 0116 |  |  |  |  |  |
| (19) | Timer 3 | 002616 | FF16 |  |  |  |  |  |
| (20) | Timer X mode register | 002716 | 0016 |  |  |  |  |  |
| (21) | Timer Y mode register | 002816 | 0016 |  |  |  |  |  |
| (22) | Timer 123 mode register | 002916 | 0016 |  |  |  |  |  |
| (23) | $\phi$ output control register | 002A16 | 0016 |  |  |  |  |  |
| (24) | A-D control register | 003416 | 0 0 | 0 | $0{ }^{0} 1$ | 0 | 0 | 0 |
| (25) | Segment output enable register | 003816 | 0016 |  |  |  |  |  |
| (26) | LCD mode register | 003916 | 0016 |  |  |  |  |  |
| (27) | Interrupt edge selection register | 003A16 | 0016 |  |  |  |  |  |
| (28) | CPU mode register | 003B16 | 0 111 | 0 | $0 \mid 1$ | 0 | 0 | 0 |
| (29) | Interrupt request register 1 | 003C16 | 0016 |  |  |  |  |  |
| (30) | Interrupt request register 2 | 003D16 | 0016 |  |  |  |  |  |
| (31) | Interrupt control register 1 | 003E16 | 0016 |  |  |  |  |  |
| (32) | Interrupt control register 2 | 003F16 | 0016 |  |  |  |  |  |
| (33) | Processor status register | (PS) | $\times$ | $\times$ | $\times 1 \times$ | 1 | $\times$ | $\times$ |
| (34) | Program counter | (PCH) | Contents of address FFFD16 |  |  |  |  |  |
|  |  | (PCL) | Contents of address FFFC16 |  |  |  |  |  |
| Note: The contents of all other registers and RAM are undefined after reset, so they must be initialized by software. <br> $X$ : undefined |  |  |  |  |  |  |  |  |

Fig. 41 Initial status of microcomputer after reset

## CLOCK GENERATING CIRCUIT

The 3822 group has two built-in oscillation circuits. An oscillation circuit can be formed by connecting a resonator between XIN and Xout (XCIN and Xcout). Use the circuit constants in accordance with the resonator manufacturer's recommended values. No external resistor is needed between XIN and Xout since a feed-back resistor exists on-chip. However, an external feed-back resistor is needed between XCIN and Xcout.
To supply a clock signal externally, input it to the XIN pin and make the Xout pin open. The sub-clock Xcin-Xcout oscillation circuit cannot directly input clocks that are externally generated. Accordingly, be sure to cause an external resonator to oscillate.
Immediately after poweron, only the XIN oscillation circuit starts oscillating, and XCIN and Xcout pins function as I/O ports.

## Frequency Control

## (1) Middle-speed Mode

The internal clock $\phi$ is the frequency of XIN divided by 8.
After reset, this mode is selected.

## (2) High-speed Mode

The internal clock $\phi$ is half the frequency of XIN.

## (3) Low-speed Mode

- The internal clock $\phi$ is half the frequency of XCIN.
- A low-power consumption operation can be realized by stopping the main clock XIN in this mode. To stop the main clock, set bit 5 of the CPU mode register to " 1 ".
When the main clock XIN is restarted, set enough time for oscillation to stabilize by programming.
Note: If you switch the mode between middle/high-speed and lowspeed, stabilize both XIN and XCIN oscillations. The sufficient time is required for the sub-clock to stabilize, especially immediately after poweron and at returning from stop mode. When switching the mode between middle/highspeed and low-speed, set the frequency on condition that $f(X I N)>3 f(X C I N)$.


## Oscillation Control

## (1) Stop Mode

If the STP instruction is executed, the internal clock $\phi$ stops at an "H" level, and XIN and XCIN oscillators stop. Timer 1 is set to "FF16" and timer 2 is set to " 0116 ".
Either XIN or XCIN divided by 16 is input to timer 1 as count source, and the output of timer 1 is connected to timer 2 . The bits of the timer 123 mode register except bit 4 are cleared to " 0 ". Set the timer 1 and timer 2 interrupt enable bits to disabled (" 0 ") before executing the STP instruction. Oscillator restarts at reset or when an external interrupt is received, but the internal clock $\phi$ is not supplied to the CPU until timer 2 underflows. This allows timer for the clock circuit oscillation to stabilize.

## (2) Wait Mode

If the WIT instruction is executed, the internal clock $\phi$ stops at an "H" level. The states of XIN and XCIN are the same as the state before the executing the WIT instruction. The internal clock restarts at reset or when an interrupt is received. Since the oscillator does not stop, normal operation can be started immediately after the clock is restarted.


Fig. 42 Ceramic resonator circuit


Fig. 43 External clock input circuit


Note : When using the low-speed mode, set the port Xc switch bit to " 1 ".

Fig. 44 Clock generating circuit block diagram


Fig. 45 State transitions of system clock

## NOTES ON PROGRAMMING <br> Processor Status Register

The contents of the processor status register (PS) after a reset are undefined, except for the interrupt disable flag (I) which is " 1 ". After a reset, initialize flags which affect program execution. In particular, it is essential to initialize the index $X$ mode ( $T$ ) and the decimal mode (D) flags because of their effect on calculations.

## Interrupt

The contents of the interrupt request bits do not change immediately after they have been written. After writing to an interrupt request register, execute at least one instruction before performing a BBC or BBS instruction.

## Decimal Calculations

- To calculate in decimal notation, set the decimal mode flag (D) to "1", then execute an ADC or SBC instruction. After executing an ADC or SBC instruction, execute at least one instruction before executing a SEC, CLC, or CLD instruction.
- In decimal mode, the values of the negative (N), overflow (V), and zero ( $Z$ ) flags are invalid.


## Timers

If a value $n$ (between 0 and 255) is written to a timer latch, the frequency division ratio is $1 /(n+1)$.

## Multiplication and Division Instructions

The index mode (T) and the decimal mode (D) flags do not affect the MUL and DIV instruction.
The execution of these instructions does not change the contents of the processor status register.

## Ports

The contents of the port direction registers cannot be read.
The following cannot be used:

- The data transfer instruction (LDA, etc.)
- The operation instruction when the index $X$ mode flag $(T)$ is " 1 "
- The addressing mode which uses the value of a direction register as an index
- The bit-test instruction (BBC or BBS, etc.) to a direction register
- The read-modify-write instruction (ROR, CLB, or SEB, etc.) to a direction register
Use instructions such as LDM and STA, etc., to set the port direction registers.


## Serial I/O

In clock synchronous serial I/O, if the receive side is using an external clock and it is to output the $\overline{\text { SRDY }}$ signal, set the transmit enable bit, the receive enable bit, and the $\overline{\text { SRDY }}$ output enable bit to "1".
Serial I/O continues to output the final bit from the TxD pin after transmission is completed.

## A-D Converter

The comparator uses internal capacitors whose charge will be lost if the clock frequency is too low.
Make sure that $f(X I N)$ is at least 500 kHz during an A-D conversion.
Do not execute the STP or WIT instruction during an A-D conversion.

## Instruction Execution Time

The instruction execution time is obtained by multiplying the frequency of the internal clock $\phi$ by the number of cycles needed to execute an instruction.
The number of cycles required to execute an instruction is shown in the list of machine instructions.
The frequency of the internal clock $\phi$ is half of the XIN frequency.

## NOTES ON USE

## Countermeasures against noise

(1) Shortest wiring length
(1) Wiring for RESET pin

Make the length of wiring which is connected to the RESET pin as short as possible. Especially, connect a capacitor across the RESET pin and the VsS pin with the shortest possible wiring (within 20mm).

Reason
The width of a pulse input into the RESET pin is determined by the timing necessary conditions. If noise having a shorter pulse width than the standard is input to the RESET pin, the reset is released before the internal state of the microcomputer is completely initialized. This may cause a program runaway.


Fig. 46 Wiring for the RESET pin
(2) Wiring for clock input/output pins

- Make the length of wiring which is connected to clock I/O pins as short as possible.
- Make the length of wiring (within 20 mm ) across the grounding lead of a capacitor which is connected to an oscillator and the Vss pin of a microcomputer as short as possible.
- Separate the Vss pattern only for oscillation from other Vss patterns.
- Reason

If noise enters clock I/O pins, clock waveforms may be deformed. This may cause a program failure or program runaway. Also, if a potential difference is caused by the noise between the Vss level of a microcomputer and the Vss level of an oscillator, the correct clock will not be input in the microcomputer.


Fig. 47 Wiring for clock I/O pins
(2) Connection of bypass capacitor across Vss line and Vcc line In order to stabilize the system operation and avoid the latch-up, connect an approximately $0.1 \mu \mathrm{~F}$ bypass capacitor across the Vss line and the Vcc line as follows:

- Connect a bypass capacitor across the Vss pin and the Vcc pin at equal length.
- Connect a bypass capacitor across the Vss pin and the Vcc pin with the shortest possible wiring.
- Use lines with a larger diameter than other signal lines for Vss line and Vcc line.
- Connect the power source wiring via a bypass capacitor to the Vss pin and the Vcc pin.


Fig. 48 Bypass capacitor across the Vss line and the Vcc line
(3) Oscillator concerns

In order to obtain the stabilized operation clock on the user system and its condition, contact the oscillator manufacturer and select the oscillator and oscillation circuit constants. Be careful especially when range of votage and temperature is wide.
Also, take care to prevent an oscillator that generates clocks for a microcomputer operation from being affected by other signals.
(1) Keeping oscillator away from large current signal lines Install a microcomputer (and especially an oscillator) as far as possible from signal lines where a current larger than the tolerance of current value flows.

- Reason

In the system using a microcomputer, there are signal lines for controlling motors, LEDs, and thermal heads or others. When a large current flows through those signal lines, strong noise occurs because of mutual inductance.
(2) Installing oscillator away from signal lines where potential levels change frequently
Install an oscillator and a connecting pattern of an oscillator away from signal lines where potential levels change frequently. Also, do not cross such signal lines over the clock lines or the signal lines which are sensitive to noise.

## - Reason

Signal lines where potential levels change frequently (such as the CNTR pin signal line) may affect other lines at signal rising edge or falling edge. If such lines cross over a clock line, clock waveforms may be deformed, which causes a microcomputer failure or a program runaway.

```
(1) Keeping oscillator away from large current signal lines
```


(2) Installing oscillator away from signal lines where potential levels change frequently

N.G.

Fig. 49 Wiring for a large current signal line/Wiring of signal lines where potential levels change frequently
(4) Analog input

The analog input pin is connected to the capacitor of a voltage comparator. Accordingly, sufficient accuracy may not be obtained by the charge/discharge current at the time of A-D conversion when the analog signal source of high-impedance is connected to an analog input pin. In order to obtain the A-D conversion result stabilized more, please lower the impedance of an analog signal source, or add the smoothing capacitor to an analog input pin.
(5) Difference of memory type and size

When Mask ROM and PROM version and memory size differ in one group, actual values such as an electrical characteristics, A-D conversion accuracy, and the amount of -proof of noise incorrect operation may differ from the ideal values.
When these products are used switching, perform system evaluation for each product of every after confirming product specification.
(6) Wiring to VPP pin of One Time PROM version

Connect an approximately $5 \mathrm{k} \Omega$ resistor to the VPP pin the shortest possible in series and also to the Vss pin.

Note: Even when a circuit which included an approximately $5 \mathrm{k} \Omega$ resistor is used in the Mask ROM version, the microcomputer operates correctly.

## - Reason

The VPP pin of the One Time PROM version is the power source input pin for the built-in PROM. When programming in the built-in PROM, the impedance of the VPP pin is low to allow the electric current for writing flow into the built-in PROM. Because of this, noise can enter easily. If noise enters the VPP pin, abnormal instruction codes or data are read from the built-in PROM, which may cause a program runaway.


Fig. 50 Wiring for the VPP pin of One Time PROM

## Electric Characteristic Differences Between Mask ROM and One Time PROM Version MCUs

There are differences in electric characteristics, operation margin, noise immunity, and noise radiation between Mask ROM and One Time PROM version MCUs due to the difference in the manufacturing processes.
When manufacturing an application system with the One TIme PROM version and then switching to use of the Mask ROM version, please perform sufficient evaluations for the commercial samples of the Mask ROM version.

## DATA REQUIRED FOR MASK ORDERS

The following are necessary when ordering a mask ROM production:
1.Mask ROM Order Confirmation Form*
2.Mark Specification Form*
3.Data to be written to ROM, in EPROM form (three identical copies) or one floppy disk
*For the mask ROM confirmation and the mark specifications, refer to the "Mitsubishi MCU Technical Information" Homepage (http://www.infomicom.maec.co.jp/).

## ROM PROGRAMMING METHOD

The built-in PROM of the blank One Time PROM version and builtin EPROM version can be read or programmed with a generalpurpose PROM programmer using a special programming adapter. Set the address of PROM programmer in the user ROM area.

Table 14 Programming adapter

| Package | Name of Programming Adapter |
| :---: | :---: |
| 80P6N-A | PCA4738F-80A |
| 80P6S-A | PCA4738G-80A |
| 80P6Q-A | PCA4738H-80A |
| 80D0 | PCA4738L-80A |

The PROM of the blank One Time PROM version is not tested or screened in the assembly process and following processes. To ensure proper operation after programming, the procedure shown in Figure 51 is recommended to verify programming.


Caution: The screening temperature is far higher than the storage temperature. Never expose to $150^{\circ} \mathrm{C}$ exceeding 100 hours.

Fig. 51 Programming and testing of One Time PROM version

Table 15 Absolute maximum ratings (Standard, One Time PROM version)

| Symbol | Parameter | Conditions | Ratings | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Vcc | Power source voltage | All voltages are based on Vss. Output transistors are cut off. | -0.3 to 7.0 | V |
| VI | Input voltage $\mathrm{P} 00-\mathrm{P} 07, \mathrm{P} 10-\mathrm{P} 17, \mathrm{P} 20-\mathrm{P} 27$, <br>  $\mathrm{P} 34-\mathrm{P} 37, \mathrm{P} 40-\mathrm{P} 47, \mathrm{P} 50-\mathrm{P57}$ <br>  $\mathrm{P} 60-\mathrm{P} 67, \mathrm{P} 70, \mathrm{P} 71$ |  | -0.3 to Vcc +0.3 | V |
| V I | Input voltage VL1 |  | -0.3 to VL2 | V |
| VI | Input voltage VL2 |  | VL1 to VL3 | V |
| VI | Input voltage VL3 |  | VL2 to Vcc +0.3 | V |
| V I | Input voltage RESET, XIN |  | -0.3 to Vcc +0.3 | V |
| Vo | Output voltage P00-P07, P10-P17 | At output port | -0.3 to Vcc +0.3 | V |
|  |  | At segment output | -0.3 to VL3+0.3 | V |
| Vo | Output voltage P34-P37 | At segment output | -0.3 to VL3+0.3 | V |
| Vo | $\begin{gathered} \text { Output voltage } \begin{array}{l} \text { P20-P27, P41-P47,P50-P57, } \\ \text { P60-P67, P70, P71 } \end{array} \end{gathered}$ |  | -0.3 to Vcc +0.3 | V |
| Vo | Output voltage SEG0-SEG11 |  | -0.3 to VL3+0.3 | V |
| Vo | Output voltage Xout |  | -0.3 to Vcc +0.3 | V |
| Pd | Power dissipation | $\mathrm{Ta}=25^{\circ} \mathrm{C}$ | 300 | mW |
| Topr | Operating temperature |  | -20 to 85 | ${ }^{\circ} \mathrm{C}$ |
| Tstg | Storage temperature |  | -40 to 125 | ${ }^{\circ} \mathrm{C}$ |

Table 16 Recommended operating conditions (Standard, One Time PROM version)
( $\mathrm{VcC}=2.5$ to $5.5 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter |  |  | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Typ. | Max. |  |
| Vcc | Power source voltage |  | High-speed mode f(XIN) $=8 \mathrm{MHz}$ | 4.0 | 5.0 | 5.5 | V |
|  |  |  | Middle-speed mode f (XIN) $=8 \mathrm{MHz}$ | 2.5 | 5.0 | 5.5 |  |
|  |  |  | Low-speed mode | 2.5 | 5.0 | 5.5 |  |
| Vss | Power source voltage |  |  |  | 0 |  | V |
| Vref | A-D conversion reference voltage |  |  | 2.0 |  | Vcc | V |
| AVss | Analog power source voltage |  |  |  | 0 |  | V |
| VIA | Analog input voltage ANo-AN7 |  |  | AVss |  | Vcc | V |
| VIH | "H" input voltage$\mathrm{P} 00-\mathrm{P} 07, \mathrm{P} 10-\mathrm{P} 17, \mathrm{P} 34-\mathrm{P} 37, \mathrm{P} 40, \mathrm{P} 41, \mathrm{P} 45, \mathrm{P} 47, \mathrm{P} 52, \mathrm{P} 53$, <br> $\mathrm{P} 56, \mathrm{P} 60-\mathrm{P} 67, \mathrm{P} 70, \mathrm{P} 71$ (CM4 $=0)$ |  |  | 0.7Vcc |  | Vcc | V |
| VIH | "H" input voltage P20-P27, P42-P44,P46,P50, P51, P54, P55, P57 |  |  | 0.8Vcc |  | Vcc | V |
| VIH | " H " input voltage RESET |  |  | 0.8 Vcc |  | Vcc | V |
| VIH | " H " input voltage XIN |  |  | 0.8 Vcc |  | Vcc | V |
| VIL | "L" input voltage | $\begin{aligned} & \text { P00-P07, P10-P17,P34-P37, P40, P41, P45, P47, P52, P53, } \\ & \text { P56,P60-P67,P70,P71 (CM4=0) } \end{aligned}$ |  | 0 |  | 0.3 Vcc | V |
| VIL | "L" input voltage P | P20-P27, P42-P44,P46,P50, P51, P54, P55, P57 |  | 0 |  | 0.2 Vcc | V |
| VIL | "L" input voltage | RESET |  | 0 |  | 0.2 Vcc | V |
| VIL | "L" input voltage | XIN |  | 0 |  | 0.2 Vcc | V |

Table 17 Recommended operating conditions (Standard, One Time PROM version)
(VcC $=2.5$ to $5.5 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter |  | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| $\Sigma \mathrm{IOH}$ (peak) | "H" total peak output current P | -P17, P20-P27 (Note 1) |  |  | -40 | mA |
| ऽlOH(peak) | "H" total peak output current P4 | P57, P60-P67, P70, P71 (Note 1) |  |  | -40 | mA |
| $\Sigma \mathrm{IOL}$ (peak) | "L" total peak output current P00 | -P17, P20-P27 (Note 1) |  |  | 40 | mA |
| $\Sigma \mathrm{IOL}$ (peak) | "L" total peak output current P | -P57, P60-P67, P70, P71 (Note 1) |  |  | 40 | mA |
| EIOH(avg) | "H" total average output current P00 | P17, P20-P27 (Note 1) |  |  | -20 | mA |
| ElOH(avg) | "H" total average output current P | P57, P60-P67, P70, P71 (Note 1) |  |  | -20 | mA |
| EloL(avg) | "L" total average output current P00 | -P17, P20-P27 (Note 1) |  |  | 20 | mA |
| EloL(avg) | "L" total average output current P4 | -P57, P60-P67, P70, P71 (Note 1) |  |  | 20 | mA |
| IOH (peak) | "H" peak output current P00 | -P17 (Note 2) |  |  | -2 | mA |
| IOH (peak) | "H" peak output current | -P47, P50-P57, P60-P67, P70, P71 |  |  | -5 | mA |
| IOL(peak) | "L" peak output current P00 | -P17 (Note 2) |  |  | 5 | mA |
| IOL(peak) | $\begin{array}{ll}\text { "L" peak output current } & \text { P20 } \\ & \text { (No }\end{array}$ | -P47, P50-P57, P60-P67, P70, P71 |  |  | 10 | mA |
| IOH(avg) | "H" average output current P00 | P17 (Note 3) |  |  | -1.0 | mA |
| $\mathrm{IOH}(\mathrm{avg})$ | "H" average output current $\quad \begin{aligned} & \text { P2 } \\ & \text { (No }\end{aligned}$ | -P47, P50-P57, P60-P67, P70, P71 |  |  | -2.5 | mA |
| IOL(avg) | "L" average output current P00 | -P17 (Note 3) |  |  | 2.5 | mA |
| IOL(avg) | "L" average output current $\quad \begin{aligned} & \text { P2 } \\ & \text { (No }\end{aligned}$ | -P47, P50-P57, P60-P67, P70, P71 |  |  | 5.0 | mA |
| f(CNTRo) | Input frequency for timers X and Y (duty cycle 50\%) | $(4.0 \mathrm{~V} \leq \mathrm{Vcc} \leq 5.5 \mathrm{~V})$ |  |  | 4.0 | MHz |
| f (CNTR1) |  | $(2.5 \mathrm{~V} \leq \mathrm{Vcc} \leq 4.0 \mathrm{~V})$ |  |  | (2XVcc)-4 | MHz |
| $f(X I N)$ | Main clock input oscillation frequency (Note 4) | High-speed mode $(4.0 \mathrm{~V} \leq \mathrm{Vcc} \leq 5.5 \mathrm{~V})$ |  |  | 8.0 | MHz |
|  |  | High-speed mode $(2.5 \mathrm{~V} \leq \mathrm{VCc} \leq 4.0 \mathrm{~V})$ |  |  | (4XVcc)-8 | MHz |
|  |  | Middle-speed mode |  |  | 8.0 | MHz |
| f (XCIN) | Sub-clock input oscillation frequency (Notes 4, 5) |  |  | 32.768 | 50 | kHz |

Notes 1: The total output current is the sum of all the currents flowing through all the applicable ports. The total average current is an average value measured over 100 ms . The total peak current is the peak value of all the currents.
2: The peak output current is the peak current flowing in each port.
3: The average output current is an average value measured over 100 ms .
4: When the oscillation frequency has a duty cycle of $50 \%$.
5: When using the microcomputer in low-speed mode, make sure that the sub-clock input oscillation frequency on condition that $f(X$ CIN $)<f(X I N) / 3$.

Table 18 Electrical characteristics (Standard, One Time PROM version)
( $\mathrm{VCC}=4.0$ to $5.5 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter | Test conditions | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| VOH | "H" output voltage P00-P07, P10-P17 | $\mathrm{IOH}=-2.5 \mathrm{~mA}$ | Vcc-2.0 |  |  | V |
|  |  | $\begin{aligned} & \mathrm{IOH}=-0.6 \mathrm{~mA} \\ & \mathrm{Vcc}=2.5 \mathrm{~V} \end{aligned}$ | Vcc-1.0 |  |  | V |
| VOH | " H " output voltage$\begin{aligned} & \text { P20-P27, P41-P47, P50-P57, P60-P67, } \\ & \text { P70, P71 (Note) } \end{aligned}$ | $\mathrm{IOH}=-5 \mathrm{~mA}$ | Vcc-2.0 |  |  | V |
|  |  | $\mathrm{IOH}=-1.25 \mathrm{~mA}$ | Vcc-0.5 |  |  | V |
|  |  | $\begin{aligned} & \mathrm{IOH}=-1.25 \mathrm{~mA} \\ & \mathrm{VCC}=2.5 \mathrm{~V} \\ & \hline \end{aligned}$ | Vcc-1.0 |  |  | V |
| Vol | "L" output voltage P00-P07, P10-P17 | $\mathrm{IOL}=5 \mathrm{~mA}$ |  |  | 2.0 | V |
|  |  | $\mathrm{IOL}=1.25 \mathrm{~mA}$ |  |  | 0.5 | V |
|  |  | $\begin{aligned} & \mathrm{IOL}=1.25 \mathrm{~mA} \\ & \mathrm{VCC}=2.5 \mathrm{~V} \end{aligned}$ |  |  | 1.0 | V |
| VoL | "L" output voltage P20-P27, P41-P47, P50-P57, P60-P67, P70, P71 (Note) | $\mathrm{IOL}=10 \mathrm{~mA}$ |  |  | 2.0 | V |
|  |  | $\mathrm{IOL}=2.5 \mathrm{~mA}$ |  |  | 0.5 | V |
|  |  | $\begin{aligned} & \mathrm{IOL}=2.5 \mathrm{~mA} \\ & \mathrm{VCC}=2.5 \mathrm{~V} \end{aligned}$ |  |  | 1.0 | V |
| $\mathrm{V} \mathrm{T}_{+}-\mathrm{V} \mathrm{T}_{-}$ | Hysteresis <br> INT0-INT3, ADT, CNTR0, CNTR1, P20-P27 |  |  | 0.5 |  | V |
| $\mathrm{V}^{+}+\mathrm{V}^{-}$ | Hysteresis ScLK, RxD |  |  | 0.5 |  | V |
| $\mathrm{V}^{+}+\mathrm{V} \mathrm{T}_{-}$ | Hysteresis $\overline{\text { RESET }}$ | RESET : Vcc $=2.5 \mathrm{~V}$ to 5.5 V |  | 0.5 |  | V |
| IIH | " H " input current P00-P07, P10-P17, P34-P37 | $\begin{aligned} & \text { VI = Vcc } \\ & \text { Pull-downs "off" } \end{aligned}$ |  |  | 5.0 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{Vcc}=5 \mathrm{~V}, \mathrm{VI}=\mathrm{Vcc}$ <br> Pull-downs "on" | 30 | 70 | 140 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{Vcc}=3 \mathrm{~V}, \quad \mathrm{VI}=\mathrm{Vcc}$ <br> Pull-downs "on" | 6.0 | 25 | 45 | $\mu \mathrm{A}$ |
| IIH | ```"H" input current P20-P27, P40-P47, P50-P57, P60-P67, P70, P71 (Note)``` | $\mathrm{VI}=\mathrm{Vcc}$ |  |  | 5.0 | $\mu \mathrm{A}$ |
| IIH | "H" input current RESET | $\mathrm{VI}=\mathrm{Vcc}$ |  |  | 5.0 | $\mu \mathrm{A}$ |
| IIH | "H" input current XIN | $\mathrm{VI}=\mathrm{Vcc}$ |  | 4.0 |  | $\mu \mathrm{A}$ |
| IIL | $\begin{aligned} & \text { "L" input current } \\ & \mathrm{P} 00-\mathrm{P} 07, \mathrm{P} 10-\mathrm{P} 17, \mathrm{P} 34-\mathrm{P} 37, \mathrm{P} 40 \end{aligned}$ | $\mathrm{VI}=\mathrm{VsS}$ |  |  | -5.0 | $\mu \mathrm{A}$ |
| IIL | $\begin{aligned} & \text { "L" input current } \\ & \text { P20-P27, P41-P47, P50-P57, P60-P67, } \\ & \text { P70, P71 (Note) } \end{aligned}$ | $\begin{aligned} & \text { VI = Vss } \\ & \text { Pull-ups "off" } \end{aligned}$ |  |  | -5.0 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{Vcc}=5 \mathrm{~V}, \mathrm{VI}=\mathrm{Vss}$ <br> Pull-ups "on" | -30 | -70 | -140 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{Vcc}=3 \mathrm{~V}, \mathrm{VI}=\mathrm{Vss}$ <br> Pull-ups "on" | -6.0 | -25 | -45 | $\mu \mathrm{A}$ |
| IIL | " L " input current $\overline{\text { RESET }}$ | $\mathrm{VI}=\mathrm{Vss}$ |  |  | -5.0 | $\mu \mathrm{A}$ |
| IIL | "L" input current XIN | $\mathrm{VI}=\mathrm{VSS}$ |  | -4.0 |  | $\mu \mathrm{A}$ |

Note: When " 1 " is set to port Xc switch bit (bit 4 at address 003B16) of the CPU mode register, the drive ability of port P70 is different from the value above mentioned.

Table 19 Electrical characteristics (Standard, One Time PROM version)
(VCC $=2.5$ to $5.5 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter | Test conditions |  | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Typ. | Max. |  |
| VRam | RAM retention voltage | At clock stop mode |  | 2.0 |  | 5.5 | V |
| ICC | Power source current | - High-speed mode, VcC $=5 \mathrm{~V}$ $\begin{aligned} & f(\mathrm{XIN})=8 \mathrm{MHz} \\ & \mathrm{f}(\mathrm{XCIN})=32.768 \mathrm{kHz} \end{aligned}$ <br> Output transistors "off" <br> A-D converter in operating |  |  | 6.4 | 13 | mA |
|  |  | - High-speed mode, Vcc = 5 V $f(X I N)=8 \mathrm{MHz}$ (in WIT state) $f(X C I N)=32.768 \mathrm{kHz}$ Output transistors "off" A-D converter stopped |  |  | 1.6 | 3.2 | mA |
|  |  | - Low-speed mode, $\mathrm{VcC}=5 \mathrm{~V}, \mathrm{Ta} \leq 55^{\circ} \mathrm{C}$ $\mathrm{f}(\mathrm{XIN})=\text { stopped }$ $\mathrm{f}(\mathrm{XCIN})=32.768 \mathrm{kHz}$ <br> Output transistors "off" |  |  | 25 | 36 | $\mu \mathrm{A}$ |
|  |  | - Low-speed mode, $\mathrm{VcC}=5 \mathrm{~V}, \mathrm{Ta}=25^{\circ} \mathrm{C}$ <br> $\mathrm{f}(\mathrm{XIN})=$ stopped <br> $\mathrm{f}(\mathrm{XCIN})=32.768 \mathrm{kHz}$ (in WIT state) <br> Output transistors "off" |  |  | 7.0 | 14 | $\mu \mathrm{A}$ |
|  |  | - Low-speed mode, $\mathrm{Vcc}=3 \mathrm{~V}, \mathrm{Ta} \leq 55^{\circ} \mathrm{C}$ $\mathrm{f}(\mathrm{XIN})=$ stopped $f(X C I N)=32.768 \mathrm{kHz}$ <br> Output transistors "off" |  |  | 15 | 22 | $\mu \mathrm{A}$ |
|  |  | - Low-speed mode, $\mathrm{Vcc}=3 \mathrm{~V}, \mathrm{Ta}=25^{\circ} \mathrm{C}$ <br> $f($ XIN $)=$ stopped <br> $\mathrm{f}(\mathrm{XCIN})=32.768 \mathrm{kHz}$ (in WIT state) <br> Output transistors "off" |  |  | 4.5 | 9.0 | $\mu \mathrm{A}$ |
|  |  | All oscillation stopped (in STP state) Output transistors "off" | $\mathrm{Ta}=25^{\circ} \mathrm{C}$ |  | 0.1 | 1.0 | $\mu \mathrm{A}$ |
|  |  |  | $\mathrm{Ta}=85{ }^{\circ} \mathrm{C}$ |  |  | 10 |  |

Table 20 A-D converter characteristics (Standard, One Time PROM version)
( $\mathrm{Vcc}=4.0$ to $5.5 \mathrm{~V}, \mathrm{VSS}=0 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}, 4 \mathrm{MHz} \leq \mathrm{f}(\mathrm{XIN}) \leq 8 \mathrm{MHz}$, middle-/high-speed mode, unless otherwise noted)

| Symbol | Parameter | Test conditions | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| - | Resolution |  |  |  | 8 | Bits |
| - | Absolute accuracy (excluding quantization error) | $\mathrm{VCC}=\mathrm{VREF}=5 \mathrm{~V}$ |  |  | $\pm 2$ | LSB |
| tCONV | Conversion time | $f(X I N)=8 \mathrm{MHz}$ |  |  | $\begin{gathered} \hline 12.5 \\ \text { (Note) } \end{gathered}$ | $\mu \mathrm{s}$ |
| Rladder | Ladder resistor |  | 12 | 35 | 100 | k $\Omega$ |
| IVREF | Reference power source input current | Vref $=5 \mathrm{~V}$ | 50 | 150 | 200 | $\mu \mathrm{A}$ |
| IIA | Analog port input current |  |  |  | 5.0 | $\mu \mathrm{A}$ |

[^1]Table 21 Timing requirements 1 (Standard, One Time PROM version)
(VCc $=4.0$ to 5.5 V , $\mathrm{VSS}=0 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |
| tw( $\overline{\mathrm{RESET}})$ | Reset input "L" pulse width | 2 |  |  | $\mu \mathrm{s}$ |
| tc(XIN) | Main clock input cycle time (XIN input) | 125 |  |  | ns |
| twh(XIN) | Main clock input "H" pulse width | 45 |  |  | ns |
| twL(XIN) | Main clock input "L" pulse width | 40 |  |  | ns |
| tc(CNTR) | CNTRo, CNTR1 input cycle time | 250 |  |  | ns |
| twH(CNTR) | CNTR0, CNTR1 input "H" pulse width | 105 |  |  | ns |
| twL(CNTR) | CNTRo, CNTR1 input "L" pulse width | 105 |  |  | ns |
| twH(INT) | INT0 to INT3 input "H" pulse width | 80 |  |  | ns |
| twL(INT) | INT0 to INT3 input "L" pulse width | 80 |  |  | ns |
| tc(ScLk) | Serial I/O clock input cycle time (Note) | 800 |  |  | ns |
| twH(Sclk) | Serial I/O clock input "H" pulse width (Note) | 370 |  |  | ns |
| twL(ScLk) | Serial I/O clock input "L" pulse width (Note) | 370 |  |  | ns |
| tsu(RxD-ScLk) | Serial I/O input set up time | 220 |  |  | ns |
| th(Sclk-RxD) | Serial I/O input hold time | 100 |  |  | ns |

Note: When bit 6 of address 001 A 16 is " 1 " (clock synchronous).
Divide this value by four when bit 6 of address 001A16 is " 0 " (UART).

Table 22 Timing requirements 2 (Standard, One Time PROM version)
( $\mathrm{VCC}=2.5$ to $4.0 \mathrm{~V}, \mathrm{VSS}=0 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |
| tw( $\overline{\text { RESET }}$ ) | Reset input "L" pulse width | 2 |  |  | $\mu \mathrm{s}$ |
| tc(XIN) | Main clock input cycle time (XIN input) | 125 |  |  | ns |
| twH(XIN) | Main clock input "H" pulse width | 45 |  |  | ns |
| twL(XIN) | Main clock input "L" pulse width | 40 |  |  | ns |
| tc(CNTR) | CNTR0, CNTR1 input cycle time | 500/(Vcc-2) |  |  | ns |
| twH(CNTR) | CNTR0, CNTR1 input "H" pulse width | 250/(Vcc-2)-20 |  |  | ns |
| twL(CNTR) | CNTR0, CNTR1 input "L" pulse width | 250/(Vcc-2)-20 |  |  | ns |
| twH(INT) | INT0 to INT3 input "H" pulse width | 230 |  |  | ns |
| twL(INT) | INT0 to INT3 input "L" pulse width | 230 |  |  | ns |
| tc(Sclk) | Serial I/O clock input cycle time (Note) | 2000 |  |  | ns |
| twH(Sclk) | Serial I/O clock input "H" pulse width (Note) | 950 |  |  | ns |
| twL(ScLk) | Serial I/O clock input "L" pulse width (Note) | 950 |  |  | ns |
| tsu(R×D-Sclk) | Serial I/O input set up time | 400 |  |  | ns |
| th(Sclk-RxD) | Serial I/O input hold time | 200 |  |  | ns |

Note: When bit 6 of address 001A16 is " 1 " (clock synchronous).
Divide this value by four when bit 6 of address 001A16 is " 0 " (UART).

Table 23 Switching characteristics 1 (Standard, One Time PROM version)
( $\mathrm{VCC}=4.0$ to $5.5 \mathrm{~V}, \mathrm{VSS}=0 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |
| twH(Sclk) | Serial I/O clock output "H" pulse width | tc (SCLK)/2-30 |  |  | ns |
| twL(ScLk) | Serial I/O clock output "L" pulse width | tc (SCLK)/2-30 |  |  | ns |
| td(Sclk-TxD) | Serial I/O output delay time (Note 1) |  |  | 140 | ns |
| tv(Sclk-TxD) | Serial I/O output valid time (Note 1) | -30 |  |  | ns |
| $\operatorname{tr}$ (Scle ) | Serial I/O clock output rising time |  |  | 30 | ns |
| tf(Scle) | Serial I/O clock output falling time |  |  | 30 | ns |
| $\operatorname{tr}$ (CMOS) | CMOS output rising time (Note 2) |  | 10 | 30 | ns |
| tf(CMOS) | CMOS output falling time (Note 2) |  | 10 | 30 | ns |

Notes 1: When the P45/TxD P-channel output disable bit of the UART control register (bit 4 of address 001B16) is " 0 ".
2: Xout and Xcout pins are excluded.

Table 24 Switching characteristics 2 (Standard, One Time PROM version)
( $\mathrm{VCC}=2.5$ to $4.0 \mathrm{~V}, \mathrm{VSS}=0 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |
| twh(Sclk) | Serial I/O clock output "H" pulse width | tc (SCLK)/2-50 |  |  | ns |
| twL(ScLk) | Serial I/O clock output "L" pulse width | tc (SCLK)/2-50 |  |  | ns |
| td(Sclk-TxD) | Serial I/O output delay time (Note 1) |  |  | 350 | ns |
| tv(ScLK-TxD) | Serial I/O output valid time (Note 1) | -30 |  |  | ns |
| $\operatorname{tr}$ (ScLK) | Serial I/O clock output rising time |  |  | 50 | ns |
| tf(ScLK) | Serial I/O clock output falling time |  |  | 50 | ns |
| $\operatorname{tr}$ (CMOS) | CMOS output rising time (Note 2) |  | 20 | 50 | ns |
| tf(CMOS) | CMOS output falling time (Note 2) |  | 20 | 50 | ns |

Notes 1: When the P45/TxD P-channel output disable bit of the UART control register (bit 4 of address 001B16) is " 0 ".
2: Xout and Xcout pins are excluded.

Table 25 Absolute maximum ratings (Extended operating temperature version)

| Symbol | Parameter | Conditions | Ratings | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Vcc | Power source voltage | All voltages are based on Vss. Output transistors are cut off. | -0.3 to 6.5 | V |
| VI | Input voltage P00-P07, P10-P17, P20-P27, <br>  P34-P37, P40-P47, P50-P57 <br>  P60-P67, P70, P71 |  | -0.3 to Vcc +0.3 | V |
| VI | Input voltage VL1 |  | -0.3 to VL2 | V |
| VI | Input voltage VL2 |  | VL1 to VL3 | V |
| VI | Input voltage VL3 |  | VL2 to VCC +0.3 | V |
| VI | Input voltage RESET, XIN |  | -0.3 to Vcc +0.3 | V |
| Vo | Output voltage P00-P07, P10-P17 | At output port | -0.3 to Vcc +0.3 | V |
|  |  | At segment output | -0.3 to VL3 | V |
| Vo | Output voltage P34-P37 | At segment output | -0.3 to VL3 | V |
| Vo | $\begin{gathered} \hline \text { Output voltage } \begin{array}{c} \text { P20-P27, P41-P47,P50-P57, } \\ \text { P60-P67, P70, P71 } \end{array} \end{gathered}$ |  | -0.3 to Vcc +0.3 | V |
| Vo | Output voltage SEG0-SEG11 |  | -0.3 to VL3 | V |
| Vo | Output voltage Xout |  | -0.3 to Vcc +0.3 | V |
| Pd | Power dissipation | $\mathrm{Ta}=25^{\circ} \mathrm{C}$ | 300 | mW |
| Topr | Operating temperature |  | -40 to 85 | ${ }^{\circ} \mathrm{C}$ |
| Tstg | Storage temperature |  | -65 to 150 | ${ }^{\circ} \mathrm{C}$ |

Table 26 Recommended operating conditions (Extended operating temperature version)
( $\mathrm{Vcc}=2.0$ to $5.5 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, and $\mathrm{VcC}=3.0$ to $5.5 \mathrm{~V}, \mathrm{Ta}=-40$ to $-20^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter |  |  |  | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | Min. | Typ. | Max. |  |
| Vcc | Power source voltage |  | High-speed mode f(XIN) $=8 \mathrm{MHz}$ |  | 4.0 | 5.0 | 5.5 | V |
|  |  |  | Middle-speed mode | $\mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$ | 2.0 | 5.0 | 5.5 |  |
|  |  |  | $\mathrm{f}(\mathrm{XIN})=8 \mathrm{MHz}$ | $\mathrm{Ta}=-40$ to $-20^{\circ} \mathrm{C}$ | 3.0 | 5.0 | 5.5 |  |
|  |  |  | Low-speed mode | $\mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$ | 2.0 | 5.0 | 5.5 |  |
|  |  |  |  | $\mathrm{Ta}=-40$ to $-20^{\circ} \mathrm{C}$ | 3.0 | 5.0 | 5.5 |  |
| Vss | Power source voltage |  |  |  |  | 0 |  | V |
| Vref | A-D conversion reference voltage |  |  |  | 2.0 |  | Vcc | V |
| AVss | Analog power source voltage |  |  |  |  | 0 |  | V |
| VIA | Analog input voltage ANo-AN7 |  |  |  | AVss |  | Vcc | V |
| VIH | "H" input voltage $\mathrm{P} 00-\mathrm{P} 07, \mathrm{P} 10-\mathrm{P} 17, \mathrm{P} 34-\mathrm{P} 37, \mathrm{P} 40, \mathrm{P} 41, \mathrm{P} 45, \mathrm{P} 47, \mathrm{P} 52, \mathrm{P} 53$, <br> $\mathrm{P} 56, \mathrm{P} 60-\mathrm{P} 67, \mathrm{P} 70, \mathrm{P} 71(\mathrm{CM} 4=0)$ |  |  |  | 0.7Vcc |  | Vcc | V |
| VIH | "H" input voltage P20-P27, P42-P44,P46, P50, P51, P54, P55, P57 |  |  |  | 0.8 VCc |  | Vcc | V |
| VIH | " H " input voltage | RESET |  |  | 0.8 VCc |  | Vcc | V |
| VIH | " H " input voltage | XIN |  |  | 0.8 VCc |  | Vcc | V |
| VIL | "L" input voltage | $\begin{aligned} & \text { P00-P07, P10-P17,P34-P37, P40, P41, P45, P47, P52, P53, } \\ & \text { P56,P60-P67,P70,P71 (CM4 = 0) } \end{aligned}$ |  |  | 0 |  | 0.3 Vcc | V |
| VIL | "L" input voltage | P20-P27 | P42-P44,P46,P50, P51 | 55, P57 | 0 |  | 0.2 Vcc | V |
| VIL | "L" input voltage | RESET |  |  | 0 |  | 0.2 Vcc | V |
| VIL | "L" input voltage | XIN |  |  | 0 |  | 0.2 Vcc | V |

Table 27 Recommended operating conditions (Extended operating temperature version)
( $\mathrm{Vcc}=2.0$ to $5.5 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, and $\mathrm{VcC}=3.0$ to $5.5 \mathrm{~V}, \mathrm{Ta}=-40$ to $-20^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter |  | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| $\Sigma \mathrm{IOH}$ (peak) | "H" total peak output current P 00 | P00-P07, P10-P17, P20-P27 (Note 1) |  |  | -40 | mA |
| $\Sigma \mathrm{IOH}$ (peak) | "H" total peak output current P41 | P41-P47, P50-P57, P60-P67, P70, P71 (Note 1) |  |  | -40 | mA |
| $\Sigma \mathrm{lOL}$ (peak) | "L" total peak output current P 00 | $\mathrm{P} 00-\mathrm{P} 07, \mathrm{P} 10-\mathrm{P} 17, \mathrm{P} 20-\mathrm{P} 27$ (Note 1) |  |  | 40 | mA |
| ElOL(peak) | "L" total peak output current P41 | P41-P47, P50-P57, P60-P67, P70, P71 (Note 1) |  |  | 40 | mA |
| E IOH (avg) | "H" total average output current P 00 | P00-P07, P10-P17, P20-P27 (Note 1) |  |  | -20 | mA |
| $\mathrm{\Sigma lOH}(\mathrm{avg})$ | "H" total average output current P41 | P41-P47, P50-P57, P60-P67, P70, P71 (Note 1) |  |  | -20 | mA |
| EloL(avg) | "L" total average output current P 00 | P00-P07, P10-P17, P20-P27 (Note 1) |  |  | 20 | mA |
| EloL(avg) | "L" total average output current P41 | P41-P47, P50-P57, P60-P67, P70, P71 (Note 1) |  |  | 20 | mA |
| IOH (peak) | "H" peak output current P 00 | P00-P07, P10-P17 (Note 2) |  |  | -2 | mA |
| IOH (peak) | "H" peak output current | $\begin{aligned} & \text { P20-P27, P41-P47, P50-P57, P60-P67, P70, P71 } \\ & \text { (Note 2) } \end{aligned}$ |  |  | -5 | mA |
| IOL(peak) | "L" peak output current P 00 | P00-P07, P10-P17 (Note 2) |  |  | 5 | mA |
| IOL(peak) | "L" peak output current $\quad \begin{array}{ll}\text { P20 } \\ \text { (No }\end{array}$ | P20-P27, P41-P47, P50-P57, P60-P67, P70, P71 <br> (Note 2) |  |  | 10 | mA |
| IOH(avg) | "H" average output current P 00 | P00-P07, P10-P17 (Note 3) |  |  | -1.0 | mA |
| $\mathrm{IOH}(\mathrm{avg})$ | $\begin{array}{ll}\text { "H" average output current } & \mathrm{P} 20 \\ \text { (No }\end{array}$ | P20-P27, P41-P47, P50-P57, P60-P67, P70, P71 <br> (Note 3) |  |  | -2.5 | mA |
| IOL(avg) | "L" average output current P 00 | P00-P07, P10-P17 (Note 3) |  |  | 2.5 | mA |
| IOL(avg) | "L" average output current $\begin{aligned} & \text { P20 } \\ & \text { (No }\end{aligned}$ | P20-P27, P41-P47, P50-P57, P60-P67, P70, P71 <br> (Note 3) |  |  | 5.0 | mA |
| f(CNTRo) | Input frequency for timers X and Y (duty cycle 50\%) | $(4.0 \mathrm{~V} \leq \mathrm{Vcc} \leq 5.5 \mathrm{~V})$ |  |  | 4.0 | MHz |
| f(CNTR1) |  | $(2.0 \mathrm{~V} \leq \mathrm{Vcc} \leq 4.0 \mathrm{~V})$ |  |  | Vcc | MHz |
| $f($ XIN $)$ | Main clock input oscillation frequency (Note 4) | High-speed mode $(4.0 \mathrm{~V} \leq \mathrm{Vcc} \leq 5.5 \mathrm{~V}$ ) |  |  | 8.0 | MHz |
|  |  | High-speed mode $(2.0 \mathrm{~V} \leq \mathrm{VCC} \leq 4.0 \mathrm{~V})$ |  |  | 2XVcc | MHz |
|  |  | Middle-speed mode |  |  | 8.0 | MHz |
| $f($ XCIN $)$ | Sub-clock input oscillation frequency (Notes 4, 5) |  |  | 32.768 | 50 | kHz |

Notes 1: The total output current is the sum of all the currents flowing through all the applicable ports. The total average current is an average value mesured over 100 ms . The total peak current is the peak value of all the currents.
2: The peak output current is the peak current flowing in each port.
3: The average output current is an average value measured over 100 ms .
4: When the oscillation frequency has a duty cycle of $50 \%$.
5: When using the microcomputer in low-speed mode, make sure that the sub-clock input oscillation frequency on condition that $f(X C I N)<f(X I N) / 3$.

Table 28 Electrical characteristics (Extended operating temperature version)
( $\mathrm{VCC}=2.0$ to $5.5 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, and $\mathrm{VCC}=3.0$ to $5.5 \mathrm{~V}, \mathrm{Ta}=-40$ to $-20^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter | Test conditions | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| Vон | " H " output voltage P00-P07, P10-P17 | $\mathrm{IOH}=-2.5 \mathrm{~mA}$ | Vcc-2.0 |  |  | V |
|  |  | $\begin{aligned} & \mathrm{IOH}=-0.6 \mathrm{~mA} \\ & \mathrm{VCC}=3.0 \mathrm{~V} \end{aligned}$ | Vcc-0.9 |  |  | V |
| Vон | ```" H " output voltage P20-P27, P41-P47, P50-P57, P60-P67, P70, P71 (Note)``` | $\mathrm{IOH}=-5 \mathrm{~mA}$ | Vcc-2.0 |  |  | V |
|  |  | $\mathrm{IOH}=-1.25 \mathrm{~mA}$ | Vcc-0.5 |  |  | V |
|  |  | $\begin{aligned} & \hline \mathrm{IOH}=-1.25 \mathrm{~mA} \\ & \mathrm{VCC}=3.0 \mathrm{~V} \end{aligned}$ | Vcc-0.9 |  |  | V |
| Vol | "L" output voltage P00-P07, P10-P17 | $\mathrm{IOL}=5 \mathrm{~mA}$ |  |  | 2.0 | V |
|  |  | $\mathrm{IOL}=1.25 \mathrm{~mA}$ |  |  | 0.5 | V |
|  |  | $\begin{aligned} & \mathrm{OL}=1.25 \mathrm{~mA} \\ & \mathrm{VCC}=3.0 \mathrm{~V} \end{aligned}$ |  |  | 1.1 | V |
| Vol | "L" output voltage P20-P27, P41-P47, P50-P57, P60-P67, <br> P70, P71 (Note) | $\mathrm{IOL}=10 \mathrm{~mA}$ |  |  | 2.0 | V |
|  |  | $\mathrm{IOL}=2.5 \mathrm{~mA}$ |  |  | 0.5 | V |
|  |  | $\begin{aligned} & \mathrm{IOL}=2.5 \mathrm{~mA} \\ & \mathrm{VCC}=3.0 \mathrm{~V} \end{aligned}$ |  |  | 1.1 | V |
|  | Hysteresis INT0-INT3, ADT, CNTR0, CNTR1, P20-P27 |  |  | 0.5 |  | V |
| $\mathrm{V}_{\text {+ }+ \text { - }} \mathrm{V}_{\text {T- }}$ | Hysteresis SCLK, RxD |  |  | 0.5 |  | V |
| $\mathrm{V}_{\text {+ }+ \text { - }} \mathrm{V}_{\text {T- }}$ | Hysteresis RESET | RESET : VCC $=2.0 \mathrm{~V}$ to 5.5 V |  | 0.5 |  | V |
| IIH | "H" input currentP00-P07, P10-P17, P34-P37 | $\begin{aligned} & V_{I}=V c c \\ & \text { Pull-dows "off" } \end{aligned}$ |  |  | 5.0 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{Vcc}=5 \mathrm{~V}, \mathrm{VI}_{\mathrm{I}}=\mathrm{Vcc}$ <br> Pull-downs "on" | 30 | 70 | 170 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{Vcc}=3 \mathrm{~V}, \mathrm{VI}=\mathrm{Vcc}$ <br> Pull-downs "on" | 6.0 | 25 | 55 | $\mu \mathrm{A}$ |
| IIH | "H" input current P20-P27, P40-P47, P50-P57, P60-P67, P70, P71 (Note) | V I $=\mathrm{Vcc}$ |  |  | 5.0 | $\mu \mathrm{A}$ |
| IIH | "H" input current $\overline{\text { RESET }}$ | V = Vcc |  |  | 5.0 | $\mu \mathrm{A}$ |
| IIH | "H" input current XIN | V I $=\mathrm{Vcc}$ |  | 4.0 |  | $\mu \mathrm{A}$ |
| IIL | "L" input current P00-P07, P10-P17, P34-P37,P40 | V I $=\mathrm{Vss}$ |  |  | -5.0 | $\mu \mathrm{A}$ |
| IIL | $\begin{aligned} & \text { "L" input current } \\ & \text { P20-P27, P41-P47, P50-P57, P60-P67, } \\ & \text { P70, P71 (Note) } \end{aligned}$ | $\begin{aligned} & V_{I}=V s s \\ & \text { Pull-ups "off" } \end{aligned}$ |  |  | -5.0 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{Vcc}=5 \mathrm{~V}, \mathrm{VI}=\mathrm{Vss}$ <br> Pull-ups "on" | -30 | -70 | -140 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{Vcc}=3 \mathrm{~V}, \mathrm{VI}=\mathrm{Vss}$ <br> Pull-ups "on" | -6.0 | -25 | -45 | $\mu \mathrm{A}$ |
| IIL | "L" input current $\overline{\text { RESET }}$ | $\mathrm{V} \mathrm{I}=\mathrm{Vss}$ |  |  | -5.0 | $\mu \mathrm{A}$ |
| IIL | "L" input current XIN | $\mathrm{V} \mathrm{I}=\mathrm{Vss}$ |  | -4.0 |  | $\mu \mathrm{A}$ |

Note: When " 1 " is set to port Xc switch bit (bit 4 at address 003B16) of CPU mode register, the drive ability of port P70 is different from the value above mentioned.

Table 29 Electrical characteristics (Extended operating temperature version)
( $\mathrm{VCC}=2.0$ to 5.5 V , $\mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, and $\mathrm{VCC}=3.0$ to 5.5 V , $\mathrm{Ta}=-40$ to $-20^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter | Test conditions |  | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Typ. | Max. |  |
| Vram | RAM retention voltage | At clock stop mode |  | 2.0 |  | 5.5 | V |
| ICC | Power source current | - High-speed mode, Vcc = 5 V $\begin{aligned} & f(\mathrm{XIN})=8 \mathrm{MHz} \\ & f(\mathrm{XCIN})=32.768 \mathrm{kHz} \end{aligned}$ <br> Output transistors "off" <br> A-D converter in operating |  |  | 6.4 | 13 | mA |
|  |  | - High-speed mode, Vcc = 5 V $\mathrm{f}(\mathrm{XIN})=8 \mathrm{MHz}$ (in WIT state) $f($ XCIN $)=32.768 \mathrm{kHz}$ <br> Output transistors "off" <br> A-D converter stopped |  |  | 1.6 | 3.2 | mA |
|  |  | - Low-speed mode, $\mathrm{Vcc}=5 \mathrm{~V}, \mathrm{Ta} \leq 55^{\circ} \mathrm{C}$ $\begin{aligned} & f(\mathrm{XIN})=\text { stopped } \\ & f(\mathrm{XCIN})=32.768 \mathrm{kHz} \end{aligned}$ <br> Output transistors "off" |  |  | 25 | 36 | $\mu \mathrm{A}$ |
|  |  | - Low-speed mode, Vcc $=5 \mathrm{~V}, \mathrm{Ta}=25^{\circ} \mathrm{C}$ <br> f(XIN) = stopped <br> $\mathrm{f}(\mathrm{XCIN})=32.768 \mathrm{kHz}$ (in WIT state) <br> Output transistors "off" |  |  | 7.0 | 14 | $\mu \mathrm{A}$ |
|  |  | - Low-speed mode, $\mathrm{VcC}=3 \mathrm{~V}, \mathrm{Ta} \leq 55^{\circ} \mathrm{C}$ $\begin{aligned} & f(\mathrm{XIN})=\text { stopped } \\ & \mathrm{f}(\mathrm{XCIN})=32.768 \mathrm{kHz} \end{aligned}$ <br> Output transistors "off" |  |  | 15 | 22 | $\mu \mathrm{A}$ |
|  |  | - Low-speed mode, $\mathrm{Vcc}=3 \mathrm{~V}, \mathrm{Ta}=25^{\circ} \mathrm{C}$ $\mathrm{f}(\mathrm{XIN})=$ stopped <br> $\mathrm{f}(\mathrm{XCIN})=32.768 \mathrm{kHz}$ (in WIT state) <br> Output transistors "off" |  |  | 4.5 | 9.0 | $\mu \mathrm{A}$ |
|  |  | All oscillation stopped (in STP state) Output transistors "off" | $\mathrm{Ta}=25^{\circ} \mathrm{C}$ |  | 0.1 | 1.0 | $\mu \mathrm{A}$ |
|  |  |  | $\mathrm{Ta}=85^{\circ} \mathrm{C}$ |  |  | 10 |  |

Table 30 A-D converter characteristics (Extended operating temperature version)
(VCC $=3.0$ to $5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSS}=0 \mathrm{~V}, \mathrm{Ta}=-40$ to $85^{\circ} \mathrm{C}, 4 \mathrm{MHz} \leq \mathrm{f}(\mathrm{XIN}) \leq 8 \mathrm{MHz}$, in middle/high-speed mode unless otherwise noted)


[^2]Table 31 Timing requirements 1 (Extended operating temperature version)
( $\mathrm{VCC}=4.0$ to $5.5 \mathrm{~V}, \mathrm{VSS}=0 \mathrm{~V}, \mathrm{Ta}=-40$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |
| tw( $\overline{\mathrm{RESET}}$ ) | Reset input "L" pulse width | 2 |  |  | $\mu \mathrm{s}$ |
| tc (XIN) | Main clock input cycle time (XIN input) | 125 |  |  | ns |
| twh(XIN) | Main clock input "H" pulse width | 45 |  |  | ns |
| twL(XIN) | Main clock input "L" pulse width | 40 |  |  | ns |
| tc(CNTR) | CNTR0, CNTR1 input cycle time | 250 |  |  | ns |
| twH(CNTR) | CNTR0, CNTR1 input "H" pulse width | 105 |  |  | ns |
| twL(CNTR) | CNTRo, CNTR1 input "L" pulse width | 105 |  |  | ns |
| twH(INT) | INT0 to INT3 input "H" pulse width | 80 |  |  | ns |
| twL(INT) | INT0 to INT3 input "L" pulse width | 80 |  |  | ns |
| tc(ScLK) | Serial I/O clock input cycle time (Note) | 800 |  |  | ns |
| twH(Sclk) | Serial I/O clock input "H" pulse width (Note) | 370 |  |  | ns |
| twL(Sclk) | Serial I/O clock input "L" pulse width (Note) | 370 |  |  | ns |
| tsu(RxD-ScLK) | Serial I/O input set up time | 220 |  |  | ns |
| th(ScLK-RxD) | Serial I/O input hold time | 100 |  |  | ns |

Note: When bit 6 of address 001A16 is " 1 " (clock synchronous).
Divide this value by four when bit 6 of address 001A16 is " 0 " (UART).

Table 32 Timing requirements $\mathbf{2}$ (Extended operating temperature version)
( $\mathrm{VCC}=2.0$ to $4.0 \mathrm{~V}, \mathrm{VSS}=0 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, and $\mathrm{VCC}=3.0$ to $4.0 \mathrm{~V}, \mathrm{Ta}=-40$ to $-20^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |
| tw( $\overline{\mathrm{RESET}})$ | Reset input "L" pulse width | 2 |  |  | $\mu \mathrm{S}$ |
| tc(Xin) | Main clock input cycle time (Xin input) | 125 |  |  | ns |
| twh(XIN) | Main clock input "H" pulse width | 45 |  |  | ns |
| twL(XIN) | Main clock input "L" pulse width | 40 |  |  | ns |
| tc(CNTR) | CNTRo, CNTR1 input cycle time | 900/(Vcc-0.4) |  |  | ns |
| twH(CNTR) | CNTR0, CNTR1 input "H" pulse width | 450/(Vcc-0.4)-20 |  |  | ns |
| twL(CNTR) | CNTR0, CNTR1 input "L" pulse width | 450/(Vcc-0.4)-20 |  |  | ns |
| twH(INT) | INT0 to INT3 input "H" pulse width | 230 |  |  | ns |
| twL(INT) | INT0 to INT3 input "L" pulse width | 230 |  |  | ns |
| tc(Sclk) | Serial I/O clock input cycle time (Note) | 2000 |  |  | ns |
| twH(ScLk) | Serial I/O clock input "H" pulse width (Note) | 950 |  |  | ns |
| twL(Sclk) | Serial I/O clock input "L" pulse width (Note) | 950 |  |  | ns |
| tsu(RxD-Sclk) | Serial I/O input set up time | 400 |  |  | ns |
| th(Sclk-RxD) | Serial I/O input hold time | 200 |  |  | ns |

Note: When bit 6 of address 001A16 is " 1 " (clock synchronous).
Divide this value by four when bit 6 of address 001A16 is " 0 " (UART).

Table 33 Switching characteristics 1 (Extended operating temperature version)
( $\mathrm{VCC}=4.0$ to 5.5 V , $\mathrm{VSS}=0 \mathrm{~V}, \mathrm{Ta}=-40$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |
| twH(Sclk) | Serial I/O clock output "H" pulse width | tc (SCLK)/2-30 |  |  | ns |
| twL(ScLk) | Serial I/O clock output "L" pulse width | tc (SCLK)/2-30 |  |  | ns |
| td(Sclk-TxD) | Serial I/O output delay time (Note 1) |  |  | 140 | ns |
| tv(Sclk-TxD) | Serial I/O output valid time (Note 1) | -30 |  |  | ns |
| $\operatorname{tr}$ (Scle) | Serial I/O clock output rising time |  |  | 30 | ns |
| tf(Sclk) | Serial I/O clock output falling time |  |  | 30 | ns |
| $\operatorname{tr}$ (CMOS) | CMOS output rising time (Note 2) |  | 10 | 30 | ns |
| tf(CMOS) | CMOS output falling time (Note 2) |  | 10 | 30 | ns |

Notes 1: When the P45/TxD P-channel output disable bit of the UART control register (bit 4 of address 001B16) is " 0 ".
2: XOUT and Xcout pins are excluded.
Table 34 Switching characteristics 2 (Extended operating temperature version)
$\left(\mathrm{VCC}=2.0\right.$ to $4.0 \mathrm{~V}, \mathrm{VsS}=0 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, and $\mathrm{VCC}=3.0$ to $4.0 \mathrm{~V}, \mathrm{VsS}=0 \mathrm{~V}, \mathrm{Ta}=-40$ to $-20^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |
| twh(Sclk) | Serial I/O clock output "H" pulse width | tc (SCLK)/2-50 |  |  | ns |
| twL(ScLk) | Serial I/O clock output "L" pulse width | tc (SCLK)/2-50 |  |  | ns |
| td(ScLk-TxD) | Serial I/O output delay time (Note 1) |  |  | 350 | ns |
| tv(ScLk-TxD) | Serial I/O output valid time (Note 1) | -30 |  |  | ns |
| $\operatorname{tr}$ (Sclk) | Serial I/O clock output rising time |  |  | 50 | ns |
| tf(ScLk) | Serial I/O clock output falling time |  |  | 50 | ns |
| $\operatorname{tr}$ (CMOS) | CMOS output rising time (Note 2) |  | 20 | 50 | ns |
| tf(CMOS) | CMOS output falling time (Note 2) |  | 20 | 50 | ns |

Notes 1: When the P45/TxD P-channel output disable bit of the UART control register (bit 4 of address 001B16) is " 0 ". 2: XOUT and XCOUT pins are excluded.

Table 35 Absolute maximum ratings ( M version)

| Symbol | Parameter | Conditions | Ratings | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Vcc | Power source voltage | All voltages are based on Vss. Output transistors are cut off. | -0.3 to 7.0 | V |
| VI | Input voltage $\mathrm{P} 00-\mathrm{P} 07, \mathrm{P} 10-\mathrm{P} 17, \mathrm{P} 20-\mathrm{P} 27$, <br>  $\mathrm{P} 34-\mathrm{P} 37, \mathrm{P} 40-\mathrm{P} 47, \mathrm{P} 50-\mathrm{P} 57$ <br>  $\mathrm{P} 60-\mathrm{P} 67, \mathrm{P} 70, \mathrm{P} 71$ |  | -0.3 to Vcc +0.3 | V |
| VI | Input voltage VL1 |  | -0.3 to VL2 | V |
| VI | Input voltage VL2 |  | VL1 to VL3 | V |
| VI | Input voltage VL3 |  | VL2 to Vcc +0.3 | V |
| VI | Input voltage $\overline{\text { RESET, XIN }}$ |  | -0.3 to Vcc +0.3 | V |
| Vo | Output voltage P00-P07, P10-P17 | At output port | -0.3 to Vcc +0.3 | V |
|  |  | At segment output | -0.3 to VL3 +0.3 | V |
| Vo | Output voltage P34-P37 | At segment output | -0.3 to VL3 +0.3 | V |
| Vo |  |  | -0.3 to Vcc +0.3 | V |
| Vo | Output voltage SEG0-SEG11 |  | -0.3 to VL3 +0.3 | V |
| Vo | Output voltage XOUT |  | -0.3 to Vcc +0.3 | V |
| Pd | Power dissipation | $\mathrm{Ta}=25^{\circ} \mathrm{C}$ | 300 | mW |
| Topr | Operating temperature |  | -20 to 85 | ${ }^{\circ} \mathrm{C}$ |
| Tstg | Storage temperature |  | -40 to 150 | ${ }^{\circ} \mathrm{C}$ |

Table 36 Recommended operating conditions (M version)
( $\mathrm{VCC}=2.2$ to 5.5 V , $\mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter |  | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| Vcc | Power source voltage | High-speed mode f(XIN) $=8 \mathrm{MHz}$ | 4.0 | 5.0 | 5.5 | V |
|  |  | Middle-speed mode $\mathrm{f}(\mathrm{XIN})=8 \mathrm{MHz}$ | 2.2 | 5.0 | 5.5 |  |
|  |  | Low-speed mode | 2.2 | 5.0 | 5.5 |  |
| Vss | Power source voltage |  |  | 0 |  | V |
| Vref | A-D conversion reference voltage |  | 2.0 |  | Vcc | V |
| AVss | Analog power source voltage |  |  | 0 |  | V |
| VIA | Analog input voltage AN0-AN7 |  | AVss |  | Vcc | V |

Table 37 Recommended operating conditions (M version)
(VCC $=2.5$ to $5.5 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter |  | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| VIH | "H" input voltage | $\begin{aligned} & \text { P00-P07, P10-P17,P34-P37, P40, P41, P45, P47, } \\ & \text { P52, P53,P56,P60-P67,P70,P71 (CM4= 0) } \end{aligned}$ | 0.7Vcc |  | Vcc | V |
| VIH | "H" input voltage | P20-P27, P42-P44,P46,P50, P51, P54, P55, P57 | 0.8 Vcc |  | Vcc | V |
| VIH | "H" input voltage | RESET | 0.8 Vcc |  | Vcc | V |
| VIH | "H" input voltage | XIN | 0.8 Vcc |  | Vcc | V |
| VIL | "L" input voltage | $\begin{aligned} & \text { P00-P07, P10-P17,P34-P37, P40, P41, P45, P47, P52, P53, } \\ & \text { P56,P60-P67,P70,P71 (CM4= 0) } \end{aligned}$ | 0 |  | 0.3 Vcc | V |
| VIL | "L" input voltage | P20-P27, P42-P44,P46, P50, P51, P54, P55, P57 | 0 |  | 0.2 Vcc | V |
| VIL | "L" input voltage | RESET | 0 |  | 0.2 Vcc | V |
| VIL | "L" input voltage | XIN | 0 |  | 0.2 Vcc | V |

Table 38 Recommended operating conditions ( $M$ version)
( $\mathrm{VCC}=2.2$ to 5.5 V , $\mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter |  | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| VIH | "H" input voltage | $\begin{aligned} & \text { P00-P07, P10-P17,P34-P37, P40, P41, P45, P47, } \\ & \text { P52, P53,P56,P60-P67,P70,P71 (CM4= 0) } \end{aligned}$ | 0.8Vcc |  | Vcc | V |
| VIH | "H" input voltage | P20-P27, P42-P44,P46, P50, P51, P54, P55, P57 | 0.95 Vcc |  | Vcc | V |
| VIH | "H" input voltage | RESET | 0.95 Vcc |  | Vcc | V |
| VIH | "H" input voltage | XIN | 0.95Vcc |  | Vcc | V |
| VIL | "L" input voltage | $\begin{aligned} & \text { P00-P07, P10-P17,P34-P37, P40, P41, P45, P47, P52, P53, } \\ & \text { P56,P60-P67,P70,P71 (CM4= 0) } \end{aligned}$ | 0 |  | 0.2 Vcc | V |
| VIL | "L" input voltage | P20-P27, P42-P44,P46, P50, P51, P54, P55, P57 | 0 |  | 0.05 Vcc | V |
| VIL | "L" input voltage | RESET | 0 |  | 0.05 Vcc | V |
| VIL | "L" input voltage | XIN | 0 |  | 0.05 Vcc | V |

Table 39 Recommended operating conditions ( $M$ version)
( $\mathrm{VCC}=2.2$ to $5.5 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter |  |  | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Typ. | Max. |  |
| $\Sigma \mathrm{IOH}$ (peak) | "H" total peak output current | P00-P07, P10-P17, P20-P27 (Note 1) |  |  |  | -40 | mA |
| ElOH(peak) | "H" total peak output current | P41-P47, P50-P57, P60-P67, P70, P71 (Note 1) |  |  |  | -40 | mA |
| ミlOL(peak) | "L" total peak output current | P00-P07, P10-P17, P20-P27 (Note 1) |  |  |  | 40 | mA |
| $\Sigma \mathrm{IOL}$ (peak) | "L" total peak output current | P41-P47, P50-P57, P60-P67, P70, P71 (Note 1) |  |  |  | 40 | mA |
| $\mathrm{\Sigma lOH}(\mathrm{avg})$ | "H" total average output current | P00-P07, P10-P17, P20-P27 (Note 1) |  |  |  | -20 | mA |
| 「 $\mathrm{IOH}(\mathrm{avg}$ ) | "H" total average output current | P41-P47, P50-P57, P60-P67, P70, P71 (Note 1) |  |  |  | -20 | mA |
| ElOL(avg) | "L" total average output current | P00-P07, P10-P17, P20-P27 (Note 1) |  |  |  | 20 | mA |
| EloL(avg) | "L" total average output current | P41-P47, P50-P57, P60-P67, P70, P71 (Note 1) |  |  |  | 20 | mA |
| IOH (peak) | "H" peak output current | P00-P07, P10-P17 (Note 2) |  |  |  | -2 | mA |
| IOH (peak) | "H" peak output current | P20-P27, P41-P47, P50-P57, P60-P67, P70, P71 <br> (Note 2) |  |  |  | -5 | mA |
| IOL(peak) | "L" peak output current | P00-P07, P10-P17 (Note 2) |  |  |  | 5 | mA |
| IOL(peak) | "L" peak output current | $\begin{aligned} & \text { P20-P27, P41-P47, P50-P57, P60-P67, P70, P71 } \\ & \text { (Note 2) } \end{aligned}$ |  |  |  | 10 | mA |
| $\mathrm{IOH}(\mathrm{avg})$ | "H" average output current | P00-P07, P10-P17 (Note 3) |  |  |  | -1.0 | mA |
| IOH(avg) | "H" average output current | P20-P27, P41-P47, P50-P57, P60-P67, P70, P71 <br> (Note 3) |  |  |  | -2.5 | mA |
| IOL(avg) | "L" average output current | P00-P07, P10-P17 (Note 3) |  |  |  | 2.5 | mA |
| IOL(avg) | " L " average output current | P20-P27, P41-P47, P50-P57, P60-P67, P70, P71 <br> (Note 3) |  |  |  | 5.0 | mA |
| f(CNTRo) | Input frequency for timers X and Y (duty cycle 50\%) |  | $(4.0 \mathrm{~V} \leq \mathrm{Vcc} \leq 5.5 \mathrm{~V})$ |  |  | 4.0 | MHz |
| f (CNTR1) |  |  | (2.2 V $\leq \mathrm{Vcc} \leq 4.0 \mathrm{~V}$ ) |  |  | (10XVcc-4)/9 | MHz |
| $f(X I N)$ | Main clock input oscillation frequency (Note 4) |  | High-speed mode $(4.0 \mathrm{~V} \leq \mathrm{Vcc} \leq 5.5 \mathrm{~V})$ |  |  | 8.0 | MHz |
|  |  |  | High-speed mode $(2.2 \mathrm{~V} \leq \mathrm{Vcc} \leq 4.0 \mathrm{~V})$ |  |  | (20XVCc-8)/9 | MHz |
|  |  |  | Middle-speed mode |  |  | 8.0 | MHz |
| $f($ XCIN $)$ | Sub-clock input oscillation frequency (Notes 4, 5) |  |  |  | 32.768 | 50 | kHz |

Notes 1: The total output current is the sum of all the currents flowing through all the applicable ports. The total average current is an average value measured over 100 ms . The total peak current is the peak value of all the currents.
2: The peak output current is the peak current flowing in each port.
3: The average output current is an average value measured over 100 ms .
4: When the oscillation frequency has a duty cycle of $50 \%$.
5: When using the microcomputer in low-speed mode, make sure that the sub-clock input oscillation frequency on condition that $f(X \operatorname{XCIN})<f(X I N) / 3$.

Table 40 Electrical characteristics (M version)
( $\mathrm{VCC}=4.0$ to $5.5 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter | Test conditions | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| VOH | "H" output voltage P00-P07, P10-P17 | $\mathrm{IOH}=-2.5 \mathrm{~mA}$ | Vcc-2.0 |  |  | V |
|  |  | $\begin{aligned} & \mathrm{IOH}=-0.6 \mathrm{~mA} \\ & \mathrm{VCC}=2.5 \mathrm{~V} \end{aligned}$ | Vcc-1.0 |  |  | V |
| VOH | "H" output voltage P20-P27, P41-P47, P50-P57, P60-P67, P70, P71 (Note) | $\mathrm{IOH}=-5 \mathrm{~mA}$ | Vcc-2.0 |  |  | V |
|  |  | $\mathrm{IOH}=-1.25 \mathrm{~mA}$ | Vcc-0.5 |  |  | V |
|  |  | $\begin{aligned} & \mathrm{IOH}=-1.25 \mathrm{~mA} \\ & \mathrm{VCC}=2.5 \mathrm{~V} \end{aligned}$ | Vcc-1.0 |  |  | V |
| VOL | "L" output voltage P00-P07, P10-P7 | $\mathrm{IOL}=5 \mathrm{~mA}$ |  |  | 2.0 | V |
|  |  | $\mathrm{IOL}=1.25 \mathrm{~mA}$ |  |  | 0.5 | V |
|  |  | $\begin{aligned} & \mathrm{IOL}=1.25 \mathrm{~mA} \\ & \mathrm{VCC}=2.5 \mathrm{~V} \end{aligned}$ |  |  | 1.0 | V |
| VOL | "L" output voltage$\begin{aligned} & \text { P20-P27, P41-P47, P50-P57, P60-P67, } \\ & \text { P70, P71 (Note) } \end{aligned}$ | $\mathrm{IOL}=10 \mathrm{~mA}$ |  |  | 2.0 | V |
|  |  | $\mathrm{IOL}=2.5 \mathrm{~mA}$ |  |  | 0.5 | V |
|  |  | $\begin{aligned} & \mathrm{IOL}=2.5 \mathrm{~mA} \\ & \mathrm{VCC}=2.5 \mathrm{~V} \end{aligned}$ |  |  | 1.0 | V |
| $\mathrm{V}^{+}$- $\mathrm{V}^{\text {T- }}$ | Hysteresis <br> INT0-INT3, ADT, CNTR0, CNTR1, P20-P27 |  |  | 0.5 |  | V |
| $\mathrm{V}_{\mathrm{T}+}$ - VT- | Hysteresis ScLK, RxD |  |  | 0.5 |  | V |
| $\mathrm{V}^{+}+\mathrm{V}_{-}$ | Hysteresis $\overline{\text { RESET }}$ | RESET : Vcc $=2.2 \mathrm{~V}$ to 5.5 V |  | 0.5 |  | V |
| IIH | " H " input current P00-P07, P10-P17, P34-P37 | $\begin{aligned} & \text { VI = Vcc } \\ & \text { Pull-downs "off" } \end{aligned}$ |  |  | 5.0 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{Vcc}=5 \mathrm{~V}, \mathrm{VI}=\mathrm{Vcc}$ <br> Pull-downs "on" | 30 | 70 | 140 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{Vcc}=3 \mathrm{~V}, \mathrm{VI}=\mathrm{Vcc}$ <br> Pull-downs "on" | 6.0 | 25 | 45 | $\mu \mathrm{A}$ |
| IIH | ```"H" input current P20-P27, P40-P47, P50-P57, P60-P67, P70, P71 (Note)``` | $\mathrm{VI}=\mathrm{Vcc}$ |  |  | 5.0 | $\mu \mathrm{A}$ |
| IIH | "H" input current RESET | $\mathrm{VI}=\mathrm{Vcc}$ |  |  | 5.0 | $\mu \mathrm{A}$ |
| IIH | "H" input current XIN | $\mathrm{VI}=\mathrm{Vcc}$ |  | 4.0 |  | $\mu \mathrm{A}$ |
| IIL | $\begin{aligned} & \text { "L" input current } \\ & \mathrm{P} 00-\mathrm{P} 07, \mathrm{P} 10-\mathrm{P} 17, \mathrm{P} 34-\mathrm{P} 37, \mathrm{P} 40 \end{aligned}$ | $\mathrm{VI}=\mathrm{VSS}$ |  |  | $-5.0$ | $\mu \mathrm{A}$ |
| IIL | $\begin{aligned} & \text { "L" input current } \\ & \text { P20-P27, P41-P47, P50-P57, P60-P67, } \\ & \text { P70, P71 (Note) } \end{aligned}$ | $\begin{aligned} & \text { VI = Vss "off" } \\ & \text { Pull-ups "ol } \end{aligned}$ |  |  | $-5.0$ | $\mu \mathrm{A}$ |
|  |  | $\mathrm{Vcc}=5 \mathrm{~V}, \mathrm{~V} \mathrm{I}=\mathrm{Vss}$ Pull-ups "on" | -30 | -70 | -140 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{Vcc}=3 \mathrm{~V}, \quad \mathrm{VI}=\mathrm{Vss}$ <br> Pull-ups "on" | -6.0 | -25 | -45 | $\mu \mathrm{A}$ |
| IIL | "L" input current RESET | $\mathrm{VI}=\mathrm{VSS}$ |  |  | -5.0 | $\mu \mathrm{A}$ |
| IIL | "L" input current XIN | $\mathrm{VI}=\mathrm{VSS}$ |  | -4.0 |  | $\mu \mathrm{A}$ |

Note: When " 1 " is set to the port Xc switch bit (bit 4 at address 003B16) of CPU mode register, the drive ability of port P7o is different from the value above mentioned.

Table 41 Electrical characteristics ( $M$ version)
( $\mathrm{VCC}=2.2$ to $5.5 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter | Test conditions |  | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Typ. | Max. |  |
| VRam | RAM retention voltage | At clock stop mode |  | 2.0 |  | 5.5 | V |
| ICC | Power source current | - High-speed mode, Vcc $=5 \mathrm{~V}$ $\begin{aligned} & f(\mathrm{XIN})=8 \mathrm{MHz} \\ & \mathrm{f}(\mathrm{XCIN})=32.768 \mathrm{kHz} \end{aligned}$ <br> Output transistors "off" <br> A-D converter in operating |  |  | 6.4 | 13 | mA |
|  |  | - High-speed mode, Vcc $=5 \mathrm{~V}$ $f(X I N)=8 \mathrm{MHz}$ (in WIT state) $\mathrm{f}(\mathrm{XCIN})=32.768 \mathrm{kHz}$ <br> Output transistors "off" <br> A-D converter stopped |  |  | 1.6 | 3.2 | mA |
|  |  | - Low-speed mode, $\mathrm{Vcc}=5 \mathrm{~V}, \mathrm{Ta} \leq 55^{\circ} \mathrm{C}$ $\begin{aligned} & f(\mathrm{XIN})=\text { stopped } \\ & f(\mathrm{XCIN})=32.768 \mathrm{kHz} \end{aligned}$ <br> Output transistors "off" |  |  | 25 | 36 | $\mu \mathrm{A}$ |
|  |  | - Low-speed mode, $\mathrm{Vcc}=5 \mathrm{~V}, \mathrm{Ta}=25^{\circ} \mathrm{C}$ <br> $\mathrm{f}(\mathrm{XIN})=$ stopped <br> $\mathrm{f}(\mathrm{XCIN})=32.768 \mathrm{kHz}$ (in WIT state) <br> Output transistors "off" |  |  | 7.0 | 14 | $\mu \mathrm{A}$ |
|  |  | - Low-speed mode, $\mathrm{Vcc}=3 \mathrm{~V}, \mathrm{Ta} \leq 55^{\circ} \mathrm{C}$ $\begin{aligned} & f(\mathrm{XIN})=\text { stopped } \\ & f(\mathrm{XCIN})=32.768 \mathrm{kHz} \end{aligned}$ <br> Output transistors "off" |  |  | 15 | 22 | $\mu \mathrm{A}$ |
|  |  | - Low-speed mode, $\mathrm{VcC}=3 \mathrm{~V}, \mathrm{Ta}=25^{\circ} \mathrm{C}$ $\mathrm{f}(\mathrm{XIN})=$ stopped $\mathrm{f}(\mathrm{XCIN})=32.768 \mathrm{kHz}$ (in WIT state) Output transistors "off" |  |  | 4.5 | 9.0 | $\mu \mathrm{A}$ |
|  |  | All oscillation stopped (in STP state) Output transistors "off" | $\mathrm{Ta}=25^{\circ} \mathrm{C}$ |  | 0.1 | 1.0 | $\mu \mathrm{A}$ |
|  |  |  | $\mathrm{Ta}=85{ }^{\circ} \mathrm{C}$ |  |  | 10 |  |

Table 42 A-D converter characteristics ( $M$ version)
( $\mathrm{VCC}=4.0$ to $5.5 \mathrm{~V}, \mathrm{VSS}=0 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}, 4 \mathrm{MHz} \leq \mathrm{f}(\mathrm{XIN}) \leq 8 \mathrm{MHz}$, in middle/high-speed mode, unless otherwise noted)

| Symbol | Parameter | Test conditions | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| - | Resolution |  |  |  | 8 | Bits |
| - | Absolute accuracy (excluding quantization error) | $\mathrm{VCC}=\mathrm{VREF}=5 \mathrm{~V}$ |  |  | $\pm 2$ | LSB |
| tCONV | Conversion time | $f(X \mathrm{IN})=8 \mathrm{MHz}$ |  |  | $\begin{gathered} 12.5 \\ \text { (Note) } \end{gathered}$ | $\mu \mathrm{s}$ |
| Rladder | Ladder resistor |  | 12 | 35 | 100 | $\mathrm{k} \Omega$ |
| IVREF | Reference power source input current | VREF $=5 \mathrm{~V}$ | 50 | 150 | 200 | $\mu \mathrm{A}$ |
| IIA | Analog port input current |  |  |  | 5.0 | $\mu \mathrm{A}$ |

Note: When an internal trigger is used in middle-speed mode, it is $14 \mu \mathrm{~s}$.

Table 43 Timing requirements 1 ( $M$ version)
( $\mathrm{VCC}=4.0$ to 5.5 V , Vss $=0 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |
| tw( $\overline{\mathrm{RESET}})$ | Reset input "L" pulse width | 2 |  |  | $\mu \mathrm{s}$ |
| tc(XIN) | Main clock input cycle time (XIN input) | 125 |  |  | ns |
| twh(XIN) | Main clock input "H" pulse width | 45 |  |  | ns |
| twL(XIN) | Main clock input "L" pulse width | 40 |  |  | ns |
| tc(CNTR) | CNTRo, CNTR1 input cycle time | 250 |  |  | ns |
| twH(CNTR) | CNTR0, CNTR1 input "H" pulse width | 105 |  |  | ns |
| twL(CNTR) | CNTRo, CNTR1 input "L" pulse width | 105 |  |  | ns |
| twH(INT) | INT0 to INT3 input "H" pulse width | 80 |  |  | ns |
| twL(INT) | INT0 to INT3 input "L" pulse width | 80 |  |  | ns |
| tc(ScLk) | Serial I/O clock input cycle time (Note) | 800 |  |  | ns |
| twH(Sclk) | Serial I/O clock input "H" pulse width (Note) | 370 |  |  | ns |
| twL(ScLk) | Serial I/O clock input "L" pulse width (Note) | 370 |  |  | ns |
| tsu(RxD-ScLk) | Serial I/O input set up time | 220 |  |  | ns |
| th(Sclk-RxD) | Serial I/O input hold time | 100 |  |  | ns |

Note: When bit 6 of address 001A16 is "1" (clock synchronous).
Divide this value by four when bit 6 of address 001A16 is " 0 " (UART).

Table 44 Timing requirements $\mathbf{2}$ ( $M$ version)
( $\mathrm{Vcc}=2.2$ to 4.0 V , $\mathrm{Vss}=0 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |
| tw(RESET) | Reset input "L" pulse width | 2 |  |  | $\mu \mathrm{s}$ |
| tc(XIN) | Main clock input cycle time (XIN input) | 125 |  |  | ns |
| twh(Xin) | Main clock input "H" pulse width | 45 |  |  | ns |
| twL(XIN) | Main clock input "L" pulse width | 40 |  |  | ns |
| tc(CNTR) | CNTR0, CNTR1 input cycle time | 900/(Vcc-0.4) |  |  | ns |
| twH(CNTR) | CNTR0, CNTR1 input "H" pulse width | 450/(Vcc-0.4)-20 |  |  | ns |
| twL(CNTR) | CNTR0, CNTR1 input "L" pulse width | 450/(Vcc-0.4)-20 |  |  | ns |
| twH(INT) | INT0 to INT3 input "H" pulse width | 230 |  |  | ns |
| twL(INT) | INT0 to INT3 input "L" pulse width | 230 |  |  | ns |
| tc(ScLK) | Serial I/O clock input cycle time (Note) | 2000 |  |  | ns |
| twH(Sclk) | Serial I/O clock input "H" pulse width (Note) | 950 |  |  | ns |
| twL(ScLk) | Serial I/O clock input "L" pulse width (Note) | 950 |  |  | ns |
| tsu(RxD-ScLk) | Serial I/O input set up time | 400 |  |  | ns |
| th(ScLK-RxD) | Serial I/O input hold time | 200 |  |  | ns |

Note: When bit 6 of address 001A16 is " 1 " (clock synchronous).
Divide this value by four when bit 6 of address 001A16 is " 0 " (UART).

Table 45 Switching characteristics $\mathbf{1}$ ( $M$ version)
(VCC $=4.0$ to $5.5 \mathrm{~V}, \mathrm{Vss}=0 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |
| twH(Sclk) | Serial I/O clock output "H" pulse width | tc (SCLK)/2-30 |  |  | ns |
| twL(ScLk) | Serial I/O clock output "L" pulse width | tc (SCLK)/2-30 |  |  | ns |
| td(Sclk-TxD) | Serial I/O output delay time (Note 1) |  |  | 140 | ns |
| tv(Sclk-TxD) | Serial I/O output valid time (Note 1) | -30 |  |  | ns |
| $\operatorname{tr}$ (ScLk) | Serial I/O clock output rising time |  |  | 30 | ns |
| tf(Sclk) | Serial I/O clock output falling time |  |  | 30 | ns |
| $\operatorname{tr}$ (CMOS) | CMOS output rising time (Note 2) |  | 10 | 30 | ns |
| tf(CMOS) | CMOS output falling time (Note 2) |  | 10 | 30 | ns |

Notes 1: When the P45/TxD P-channel output disable bit of the UART control register (bit 4 of address 001B16) is " 0 ".
2: Xout and Xcout pins are excluded.
Table 46 Switching characteristics $\mathbf{2}$ ( $M$ version)
(VCC = 2.2 to 4.0 V, Vss = $0 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |
| twh(Sclk) | Serial I/O clock output "H" pulse width | tc (SCLK)/2-50 |  |  | ns |
| twL(Sclk) | Serial I/O clock output "L" pulse width | tc (SCLK)/2-50 |  |  | ns |
| td(ScLk-TxD) | Serial I/O output delay time (Note 1) |  |  | 350 | ns |
| $\operatorname{tv}($ ScLK-TxD) | Serial I/O output valid time (Note 1) | -30 |  |  | ns |
| $\operatorname{tr}$ (Scle) | Serial I/O clock output rising time |  |  | 50 | ns |
| tf(ScLk) | Serial I/O clock output falling time |  |  | 50 | ns |
| $\operatorname{tr}$ (CMOS) | CMOS output rising time (Note 2) |  | 20 | 50 | ns |
| tf(CMOS) | CMOS output falling time (Note 2) |  | 20 | 50 | ns |

Notes 1: When the P45/TxD P-channel output disable bit of the UART control register (bit 4 of address 001B16) is " 0 ".
2: Xout and Xcout pins are excluded.

Table 47 Absolute maximum ratings ( H version)

| Symbol | Parameter | Conditions | Ratings | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Vcc | Power source voltage | All voltages are based on Vss. Output transistors are cut off. | -0.3 to 6.5 | V |
| VI | Input voltage $\mathrm{P} 00-\mathrm{P} 07, \mathrm{P} 10-\mathrm{P} 17, \mathrm{P} 20-\mathrm{P} 27$, <br>  $\mathrm{P} 34-\mathrm{P} 37, \mathrm{P} 40-\mathrm{P} 47, \mathrm{P} 50-\mathrm{P} 57$ <br>  $\mathrm{P} 60-\mathrm{P} 67, \mathrm{P} 70, \mathrm{P} 71$ |  | -0.3 to Vcc +0.3 | V |
| VI | Input voltage VL1 |  | -0.3 to VL2 | V |
| VI | Input voltage VL2 |  | VL1 to VL3 | V |
| VI | Input voltage VL3 |  | VL2 to Vcc +0.3 | V |
| VI | Input voltage $\overline{\text { RESET, XIN }}$ |  | -0.3 to Vcc +0.3 | V |
| Vo | Output voltage P00-P07, P10-P17 | At output port | -0.3 to Vcc +0.3 | V |
|  |  | At segment output | -0.3 to VL3 | V |
| Vo | Output voltage P34-P37 | At segment output | -0.3 to VL3 | V |
| Vo |  |  | -0.3 to Vcc +0.3 | V |
| Vo | Output voltage SEG0-SEG11 |  | -0.3 to VL3 | V |
| Vo | Output voltage XOUT |  | -0.3 to Vcc +0.3 | V |
| Pd | Power dissipation | $\mathrm{Ta}=25^{\circ} \mathrm{C}$ | 300 | mW |
| Topr | Operating temperature |  | -20 to 85 | ${ }^{\circ} \mathrm{C}$ |
| Tstg | Storage temperature |  | -40 to 150 | ${ }^{\circ} \mathrm{C}$ |

Table 48 Recommended operating conditions (H version)
( $\mathrm{VCC}=2.0$ to 5.5 V , $\mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter |  |  | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Typ. | Max. |  |
| Vcc | Power source voltage |  | High-speed mode $\mathrm{f}(\mathrm{XIN})=8 \mathrm{MHz}$ | 4.0 | 5.0 | 5.5 | V |
|  |  |  | Middle-speed mode $\mathrm{f}(\mathrm{XIN})=8 \mathrm{MHz}$ | 2.0 | 5.0 | 5.5 |  |
|  |  |  | Low-speed mode | 2.0 | 5.0 | 5.5 |  |
| Vss | Power source voltage |  |  |  | 0 |  | V |
| Vref | A-D conversion reference voltage |  |  | 2.0 |  | Vcc | V |
| AVsS | Analog power source voltage |  |  |  | 0 |  | V |
| VIA | Analog input voltage AN0-AN7 |  |  | AVss |  | Vcc | V |
| VIH | "H" input voltage $\mathrm{P00-P07}, \mathrm{P10-P17,P34-P37}, \mathrm{P40}, \mathrm{P41}, \mathrm{P45}, \mathrm{P47}, \mathrm{P52}, \mathrm{P53}$, <br>  P56,P60-P67,P70,P71 (CM4= 0) |  |  | 0.7Vcc |  | Vcc | V |
| VIH | "H" input voltage P20-P27, P42-P44,P46,P50, P51, P54, P55, P57 |  |  | 0.8Vcc |  | Vcc | V |
| VIH | "H" input voltage | RESET |  | 0.8Vcc |  | Vcc | V |
| VIH | "H" input voltage | XIN |  | 0.8Vcc |  | Vcc | V |
| VIL | "L" input voltage | $\begin{aligned} & \text { P00-P07, P10-P17,P34-P37, P40, P41, P45, P47, P52, P53, } \\ & \text { P56,P60-P67,P70,P71 (CM4=0) } \end{aligned}$ |  | 0 |  | 0.3 Vcc | V |
| VIL | "L" input voltage P | P20-P27 | P42-P44,P46, P50, P51, P54, P55, P57 | 0 |  | 0.2 Vcc | V |
| VIL | "L" input voltage | RESET |  | 0 |  | 0.2 Vcc | V |
| VIL | "L" input voltage | XIN |  | 0 |  | 0.2 Vcc | V |

Table 49 Recommended operating conditions (H version)
( $\mathrm{VCC}=2.0$ to $5.5 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter |  |  |  | Limits |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Typ. | Max. |  |
| $\Sigma \mathrm{IOH}$ (peak) | "H" total peak output current | P00-P07, P10-P17, P20-P27 (Note 1) |  |  |  | -40 | mA |
| ElOH(peak) | "H" total peak output current | P41-P47, P50-P57, P60-P67, P70, P71 (Note 1) |  |  |  | -40 | mA |
| ミlOL(peak) | "L" total peak output current | P00-P07, P10-P17, P20-P27 (Note 1) |  |  |  | 40 | mA |
| $\Sigma \mathrm{IOL}$ (peak) | "L" total peak output current | P41-P47, P50-P57, P60-P67, P70, P71 (Note 1) |  |  |  | 40 | mA |
| $\mathrm{\Sigma lOH}(\mathrm{avg})$ | "H" total average output current | P00-P07, P10-P17, P20-P27 (Note 1) |  |  |  | -20 | mA |
| 「 $\mathrm{IOH}(\mathrm{avg}$ ) | "H" total average output current | P41-P47, P50-P57, P60-P67, P70, P71 (Note 1) |  |  |  | -20 | mA |
| ElOL(avg) | "L" total average output current | P00-P07, P10-P17, P20-P27 (Note 1) |  |  |  | 20 | mA |
| EloL(avg) | "L" total average output current | P41-P47, P50-P57, P60-P67, P70, P71 (Note 1) |  |  |  | 20 | mA |
| IOH (peak) | "H" peak output current | P00-P07, P10-P17 (Note 2) |  |  |  | -2 | mA |
| IOH (peak) | "H" peak output current | P20-P27, P41-P47, P50-P57, P60-P67, P70, P71 <br> (Note 2) |  |  |  | -5 | mA |
| IOL(peak) | "L" peak output current | P00-P07, P10-P17 (Note 2) |  |  |  | 5 | mA |
| IOL(peak) | "L" peak output current | $\begin{aligned} & \text { P20-P27, P41-P47, P50-P57, P60-P67, P70, P71 } \\ & \text { (Note 2) } \end{aligned}$ |  |  |  | 10 | mA |
| $\mathrm{IOH}(\mathrm{avg})$ | "H" average output current | P00-P07, P10-P17 (Note 3) |  |  |  | -1.0 | mA |
| IOH(avg) | "H" average output current | $\begin{aligned} & \text { P20-P27, P41-P47, P50-P57, P60-P67, P70, P71 } \\ & \text { (Note 3) } \end{aligned}$ |  |  |  | -2.5 | mA |
| IOL(avg) | "L" average output current | P00-P07, P10-P17 (Note 3) |  |  |  | 2.5 | mA |
| IOL(avg) | " L " average output current | P20-P27, P41-P47, P50-P57, P60-P67, P70, P71 <br> (Note 3) |  |  |  | 5.0 | mA |
| f(CNTRo) | Input frequency for timers X and Y (duty cycle 50\%) |  | $(4.0 \mathrm{~V} \leq \mathrm{VCc} \leq 5.5 \mathrm{~V})$ |  |  | 4.0 | MHz |
| f (CNTR1) |  |  | $(2.0 \mathrm{~V} \leq \mathrm{Vcc} \leq 4.0 \mathrm{~V})$ |  |  | Vcc | MHz |
| $f(X I N)$ | Main clock input oscillation frequency (Note 4) |  | High-speed mode $(4.0 \mathrm{~V} \leq \mathrm{VCc} \leq 5.5 \mathrm{~V})$ |  |  | 8.0 | MHz |
|  |  |  | High-speed mode $(2.0 \mathrm{~V} \leq \mathrm{Vcc} \leq 4.0 \mathrm{~V})$ |  |  | 2XVcc | MHz |
|  |  |  | Middle-speed mode |  |  | 8.0 | MHz |
| $f($ XCIN $)$ | Sub-clock input oscillation frequency (Notes 4, 5) |  |  |  | 32.768 | 50 | kHz |

Notes 1: The total output current is the sum of all the currents flowing through all the applicable ports. The total average current is an average value measured over 100 ms . The total peak current is the peak value of all the currents.
2: The peak output current is the peak current flowing in each port.
3: The average output current is an average value measured over 100 ms .
4: When the oscillation frequency has a duty cycle of $50 \%$.
5: When using the microcomputer in low-speed mode, make sure that the sub-clock input oscillation frequency on condition that $f(X C I N)<f(X I N) / 3$.

Table 50 Electrical characteristics (H version)
( $\mathrm{VCC}=4.0$ to $5.5 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter | Test conditions | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| VOH | "H" output voltage P00-P07, P10-P17 | $\mathrm{IOH}=-2.5 \mathrm{~mA}$ | Vcc-2.0 |  |  | V |
|  |  | $\begin{aligned} & \mathrm{IOH}=-0.6 \mathrm{~mA} \\ & \mathrm{VCC}=2.5 \mathrm{~V} \end{aligned}$ | Vcc-1.0 |  |  | V |
| VOH | "H" output voltage$\begin{aligned} & \text { P20-P27, P41-P47, P50-P57, P60-P67, } \\ & \text { P70, P71 (Note) } \end{aligned}$ | $\mathrm{IOH}=-5 \mathrm{~mA}$ | Vcc-2.0 |  |  | V |
|  |  | $\mathrm{IOH}=-1.25 \mathrm{~mA}$ | Vcc-0.5 |  |  | V |
|  |  | $\begin{aligned} & \mathrm{IOH}=-1.25 \mathrm{~mA} \\ & \mathrm{VCC}=2.5 \mathrm{~V} \end{aligned}$ | Vcc-1.0 |  |  | V |
| Vol | "L" output voltage P00-P07, P10-P7 | $\mathrm{IOL}=5 \mathrm{~mA}$ |  |  | 2.0 | V |
|  |  | $\mathrm{IOL}=1.25 \mathrm{~mA}$ |  |  | 0.5 | V |
|  |  | $\begin{aligned} & \mathrm{IOL}=1.25 \mathrm{~mA} \\ & \mathrm{VCC}=2.5 \mathrm{~V} \end{aligned}$ |  |  | 1.0 | V |
| Vol | "L" output voltage$\begin{aligned} & \text { P20-P27, P41-P47, P50-P57, P60-P67, } \\ & \text { P70, P71 (Note) } \end{aligned}$ | $\mathrm{IOL}=10 \mathrm{~mA}$ |  |  | 2.0 | V |
|  |  | $\mathrm{IOL}=2.5 \mathrm{~mA}$ |  |  | 0.5 | V |
|  |  | $\begin{aligned} & \mathrm{IOL}=2.5 \mathrm{~mA} \\ & \mathrm{VCC}=2.5 \mathrm{~V} \end{aligned}$ |  |  | 1.0 | V |
| $\mathrm{V} \mathrm{T}_{+}-\mathrm{V}^{-}$ | Hysteresis <br> INT0-INT3, ADT, CNTR0, CNTR1, P20-P27 |  |  | 0.5 |  | V |
| $\mathrm{V} \mathrm{T}_{+}-\mathrm{VT}_{-}$ | Hysteresis SCLK, RxD |  |  | 0.5 |  | V |
| $\mathrm{V} \mathrm{T}_{+}-\mathrm{V}^{-}$ | Hysteresis $\overline{\text { RESET }}$ | RESET : Vcc $=2.0 \mathrm{~V}$ to 5.5 V |  | 0.5 |  | V |
| IIH | " H " input current P00-P07, P10-P17, P34-P37 | $\mathrm{VI}_{\mathrm{I}}=\mathrm{Vcc}$ <br> Pull-downs "off" |  |  | 5.0 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{Vcc}=5 \mathrm{~V}, \mathrm{~V} \mathrm{I}=\mathrm{Vcc}$ <br> Pull-downs "on" | 30 | 70 | 140 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{Vcc}=3 \mathrm{~V}, \mathrm{~V} \mathrm{I}=\mathrm{Vcc}$ <br> Pull-downs "on" | 6.0 | 25 | 45 | $\mu \mathrm{A}$ |
| IIH | ```"H" input current P20-P27, P40-P47, P50-P57, P60-P67, P70, P71 (Note)``` | $\mathrm{VI}=\mathrm{Vcc}$ |  |  | 5.0 | $\mu \mathrm{A}$ |
| IIH | "H" input current RESET | $\mathrm{VI}=\mathrm{Vcc}$ |  |  | 5.0 | $\mu \mathrm{A}$ |
| IIH | "H" input current XIN | $\mathrm{VI}=\mathrm{Vcc}$ |  | 4.0 |  | $\mu \mathrm{A}$ |
| IIL | "L" input current P00-P07, P10-P17, P34-P37,P40 | $\mathrm{VI}=\mathrm{VsS}$ |  |  | $-5.0$ | $\mu \mathrm{A}$ |
| IIL | $\begin{aligned} & \text { "L" input current } \\ & \text { P20-P27, P41-P47, P50-P57, P60-P67, } \\ & \text { P70, P71 (Note) } \end{aligned}$ | $\mathrm{VI}=\mathrm{VSS}$ <br> Pull-ups "off" |  |  | $-5.0$ | $\mu \mathrm{A}$ |
|  |  | $\mathrm{Vcc}=5 \mathrm{~V}, \mathrm{VI}=\mathrm{Vss}$ <br> Pull-ups "on" | -30 | -70 | -140 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{Vcc}=3 \mathrm{~V}, \mathrm{VI}=\mathrm{Vss}$ <br> Pull-ups "on" | -6.0 | -25 | -45 | $\mu \mathrm{A}$ |
| IIL | "L" input current RESET | $\mathrm{VI}=\mathrm{VsS}$ |  |  | 5.0 | $\mu \mathrm{A}$ |
| IIL | "L" input current XIN | $\mathrm{VI}=\mathrm{VSS}$ |  | -4.0 |  | $\mu \mathrm{A}$ |

Note: When " 1 " is set to the port Xc switch bit (bit 4 at address 003B16) of CPU mode register, the drive ability of port P7o is different from the value above mentioned.

Table 51 Electrical characteristics ( H version)
(VCC $=2.0$ to 5.5 V , $\mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter | Test conditions |  | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Typ. | Max. |  |
| VRam | RAM retention voltage | At clock stop mode |  | 2.0 |  | 5.5 | V |
| ICC | Power source current | - High-speed mode, Vcc $=5 \mathrm{~V}$ $\begin{aligned} & f(\mathrm{XIN})=8 \mathrm{MHz} \\ & \mathrm{f}(\mathrm{XCIN})=32.768 \mathrm{kHz} \end{aligned}$ <br> Output transistors "off" <br> A-D converter in operating |  |  | 6.4 | 13 | mA |
|  |  | - High-speed mode, Vcc $=5 \mathrm{~V}$ $f(X I N)=8 \mathrm{MHz}$ (in WIT state) $\mathrm{f}(\mathrm{XCIN})=32.768 \mathrm{kHz}$ <br> Output transistors "off" <br> A-D converter stopped |  |  | 1.6 | 3.2 | mA |
|  |  | - Low-speed mode, $\mathrm{Vcc}=5 \mathrm{~V}, \mathrm{Ta} \leq 55^{\circ} \mathrm{C}$ $\begin{aligned} & f(\mathrm{XIN})=\text { stopped } \\ & f(\mathrm{XCIN})=32.768 \mathrm{kHz} \end{aligned}$ <br> Output transistors "off" |  |  | 25 | 36 | $\mu \mathrm{A}$ |
|  |  | - Low-speed mode, $\mathrm{Vcc}=5 \mathrm{~V}, \mathrm{Ta}=25^{\circ} \mathrm{C}$ <br> $\mathrm{f}(\mathrm{XIN})=$ stopped <br> $\mathrm{f}(\mathrm{XCIN})=32.768 \mathrm{kHz}$ (in WIT state) <br> Output transistors "off" |  |  | 7.0 | 14 | $\mu \mathrm{A}$ |
|  |  | - Low-speed mode, $\mathrm{Vcc}=3 \mathrm{~V}, \mathrm{Ta} \leq 55^{\circ} \mathrm{C}$ $\begin{aligned} & f(\mathrm{XIN})=\text { stopped } \\ & f(\mathrm{XCIN})=32.768 \mathrm{kHz} \end{aligned}$ <br> Output transistors "off" |  |  | 15 | 22 | $\mu \mathrm{A}$ |
|  |  | - Low-speed mode, $\mathrm{VcC}=3 \mathrm{~V}, \mathrm{Ta}=25^{\circ} \mathrm{C}$ $\mathrm{f}(\mathrm{XIN})=$ stopped $\mathrm{f}(\mathrm{XCIN})=32.768 \mathrm{kHz}$ (in WIT state) Output transistors "off" |  |  | 4.5 | 9.0 | $\mu \mathrm{A}$ |
|  |  | All oscillation stopped (in STP state) Output transistors "off" | $\mathrm{Ta}=25^{\circ} \mathrm{C}$ |  | 0.1 | 1.0 | $\mu \mathrm{A}$ |
|  |  |  | $\mathrm{Ta}=85{ }^{\circ} \mathrm{C}$ |  |  | 10 |  |

Table 52 A-D converter characteristics (H version)
$\left(\mathrm{VCC}=2.2\right.$ to $5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSS}=0 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}, 4 \mathrm{MHz} \leq \mathrm{f}(\mathrm{XIN}) \leq 8 \mathrm{MHz}$, in middle/high-speed mode unless otherwise noted)


Note: When an internal trigger is used in middle-speed mode, it is $14 \mu \mathrm{~s}$.

Table 53 Timing requirements 1 ( H version)
(VCC $=4.0$ to $5.5 \mathrm{~V}, \mathrm{Vss}=0 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |
| tw( $\overline{\text { RESET }}$ ) | Reset input "L" pulse width | 2 |  |  | $\mu \mathrm{s}$ |
| tc(XIN) | Main clock input cycle time (XIN input) | 125 |  |  | ns |
| twh(XIN) | Main clock input "H" pulse width | 45 |  |  | ns |
| twL(XIN) | Main clock input "L" pulse width | 40 |  |  | ns |
| tc(CNTR) | CNTRo, CNTR1 input cycle time | 250 |  |  | ns |
| twH(CNTR) | CNTR0, CNTR1 input "H" pulse width | 105 |  |  | ns |
| twL(CNTR) | CNTRo, CNTR1 input "L" pulse width | 105 |  |  | ns |
| twH(INT) | INT0 to INT3 input "H" pulse width | 80 |  |  | ns |
| twL(INT) | INT0 to INT3 input "L" pulse width | 80 |  |  | ns |
| tc(Sclk) | Serial I/O clock input cycle time (Note) | 800 |  |  | ns |
| twH(Sclk) | Serial I/O clock input "H" pulse width (Note) | 370 |  |  | ns |
| twL(ScLk) | Serial I/O clock input "L" pulse width (Note) | 370 |  |  | ns |
| tsu(RxD-Sclk) | Serial I/O input set up time | 220 |  |  | ns |
| th(Sclk-RxD) | Serial I/O input hold time | 100 |  |  | ns |

Note: When bit 6 of address 001A16 is " 1 " (clock synchronous).
Divide this value by four when bit 6 of address 001A16 is " 0 " (UART).

Table 54 Timing requirements 2 ( H version)
(VCC = 2.0 to $4.0 \mathrm{~V}, \mathrm{VsS}=0 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |
| tw( $\overline{\mathrm{RESET}})$ | Reset input "L" pulse width | 2 |  |  | $\mu \mathrm{s}$ |
| tc(XIN) | Main clock input cycle time (XIN input) | 125 |  |  | ns |
| twh(XIN) | Main clock input "H" pulse width | 45 |  |  | ns |
| twL(XIN) | Main clock input "L" pulse width | 40 |  |  | ns |
| tc(CNTR) | CNTR0, CNTR1 input cycle time | 900/(Vcc-0.4) |  |  | ns |
| twH(CNTR) | CNTR0, CNTR1 input "H" pulse width | 450/(Vcc-0.4)-20 |  |  | ns |
| twL(CNTR) | CNTR0, CNTR1 input "L" pulse width | 450/(Vcc-0.4)-20 |  |  | ns |
| twH(INT) | INT0 to INT3 input "H" pulse width | 230 |  |  | ns |
| twL(INT) | INT0 to INT3 input "L" pulse width | 230 |  |  | ns |
| tc(ScLk) | Serial I/O clock input cycle time (Note) | 2000 |  |  | ns |
| twH(Sclk) | Serial I/O clock input "H" pulse width (Note) | 950 |  |  | ns |
| twL(Sclk) | Serial I/O clock input "L" pulse width (Note) | 950 |  |  | ns |
| tsu(RxD-ScLK) | Serial I/O input set up time | 400 |  |  | ns |
| th(ScLk-RxD) | Serial I/O input hold time | 200 |  |  | ns |

Note: When bit 6 of address 001A16 is " 1 " (clock synchronous).
Divide this value by four when bit 6 of address 001A16 is " 0 " (UART).

Table 55 Switching characteristics 1 ( H version)
(VcC $=4.0$ to 5.5 V , Vss $=0 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |
| twH(Sclk) | Serial I/O clock output "H" pulse width | tc (SCLK)/2-30 |  |  | ns |
| twL(ScLk) | Serial I/O clock output "L" pulse width | tc (SCLK)/2-30 |  |  | ns |
| td(Sclk-TxD) | Serial I/O output delay time (Note 1) |  |  | 140 | ns |
| tv(Sclk-TxD) | Serial I/O output valid time (Note 1) | -30 |  |  | ns |
| $\operatorname{tr}$ (ScLK) | Serial I/O clock output rising time |  |  | 30 | ns |
| tf(Sclk) | Serial I/O clock output falling time |  |  | 30 | ns |
| $\operatorname{tr}$ (CMOS) | CMOS output rising time (Note 2) |  | 10 | 30 | ns |
| tf(CMOS) | CMOS output falling time (Note 2) |  | 10 | 30 | ns |

Notes1: When the P45/TxD P-channel output disable bit of the UART control register (bit 4 of address 001B16) is " 0 ".
2: Xout and Xcout pins are excluded.
Table 56 Switching characteristics 2 ( H version)
(VCC $=2.0$ to $4.0 \mathrm{~V}, \mathrm{VSS}=0 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |
| twH(Sclk) | Serial I/O clock output "H" pulse width | tc (SCLK)/2-50 |  |  | ns |
| twL(ScLk) | Serial I/O clock output "L" pulse width | tc (SCLK)/2-50 |  |  | ns |
| td(Sclk-TxD) | Serial I/O output delay time (Note 1) |  |  | 350 | ns |
| tv(ScLk-TxD) | Serial I/O output valid time (Note 1) | -30 |  |  | ns |
| $\operatorname{tr}$ (Scle) | Serial I/O clock output rising time |  |  | 50 | ns |
| tf(Sclk) | Serial I/O clock output falling time |  |  | 50 | ns |
| $\operatorname{tr}$ (CMOS) | CMOS output rising time (Note 2) |  | 20 | 50 | ns |
| tf(CMOS) | CMOS output falling time (Note 2) |  | 20 | 50 | ns |

Notes1: When the P45/TxD P-channel output disable bit of the UART control register (bit 4 of address 001B16) is " 0 ".
2: XOUT and Xcout pins are excluded.


Fig. 52 Circuit for measuring output switching characteristics


Fig. 53 Timing diagram

## PACKAGE OUTLINE

## 80P6N-A MMP

| EIAJ Package Code | JEDEC Code | Weight(g) | Lead Material |
| :---: | :---: | :---: | :---: |
| QFP80-P-1420-0.80 | - | 1.58 | Alloy 42 |



80P6S-A MMP

Plastic 80 pin $14 \times 14 \mathrm{~mm}$ body QFP

| EIAJ Package Code | JEDEC Code | Weight(g) | Lead Material |
| :---: | :---: | :---: | :---: |
| QFP80-P-1414-0.65 |  | 1.11 | Alloy 42 |




Recommended Mount Pad

| Symbol | Dimension in Millimeters |  |  |
| :---: | :---: | :---: | :---: |
|  | Min | Nom | Max |
| A | - | - | 3.05 |
| A1 | 0 | 0.1 | 0.2 |
| A2 | - | 2.8 | - |
| b | 0.25 | 0.3 | 0.4 |
| c | 0.13 | 0.15 | 0.2 |
| D | 13.8 | 14.0 | 14.2 |
| E | 13.8 | 14.0 | 14.2 |
| E | - | 0.65 | - |
| HD | 16.5 | 16.8 | 17.1 |
| HE | 16.5 | 16.8 | 17.1 |
| L | 0.4 | 0.6 | 0.8 |
| L1 | - | 1.4 | - |
| X | - | - | 0.13 |
| y | - | - | 0.1 |
| $\theta$ | $0^{\circ}$ | - | $10^{\circ}$ |
| b2 | - | 0.35 | - |
| I2 | 1.3 | - | - |
| MD | - | 14.6 | - |
| ME | - | 14.6 | - |

Renesas Technology Corp.


## RenesasTechnology Corp. <br> Nippon Bldg.,6-2,Otemachi 2-chome,Chiyoda-ku,Tokyo,100-0004 Japan

Keep safety first in your circuit designs!
Mitsubishi Electric Corporation puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal injury, fire or property damage. Remember to give due consideration to safety when making your circuit designs, with appropriate measures such as (i) placement of substitutive, auxiliary circuits, (ii) use of non-flammable material or (iii) prevention against any malfunction or mishap.

## Notes regarding these materials

These materials are intended as a reference to assist our customers in the selection of the Mitsubishi semiconductor product best suited to the customer's application; they do not convey any license under any intellectual property rights, or any other rights, belonging to Mitsubishi Electric Corporation or a third party,
Mitsubishi Electric Corporation assumes no responsibility for any damage, or infringement of any third-party's rights, originating in the use of any product data, diagrams, charts, programs, algorithms, or circuit application examples All information contained in
Mitsubishi Electric Corporation without notice due to product improvements or other rograms and algorithms represents information on products at the time of publication of these materials, and are subject to change by The intor for the latest product information before purchasing a product listed herein.
The information described here may contain technical inaccuracies or typographical errors. Mitsubishi Electric Corporation assumes no responsibility for any damage, liability, or other loss rising from these inaccuracies or errors. Please also pay attention to information published by Mitsubishi Electric Corporation by various means, including the Mitsubishi Semiconductor home page (http://www.mitsubishichips.com).
When using any or all of the information contained in these materials, including product data, diagrams, charts, programs, and algorithms, please be sure to evaluate all information as a total sys
on the applicability of the information and products. Mitsubishi Electric Corporation assumes no responsibility for any damage, liability or other loss resulting from the information contained herein
Missubishi Electric Corporation semiconductors are not designed or manufactured for use in a device or system that is used under circumstances in which human life is potentially at stake. Please contact Mitsubishi Electric
Corporation or an authorized Mitsubishi Semiconductor product distributor when considering the use of a product contained herein for any specific purposes, such as apparatus or systems for transportation, vehicular, medical, aerospace, nuclear, or undersea repeater use.
If these products or technologies are subject to the Japanese export control restrictions, they must be exported under a license from the Japanese government and cannot be imported into a country other than the approved destination.
Any diversion or reexport contrary to the export control laws and regulations of Japan and/or the country of destination is prohibited
Please contact Mitsubishi Electric Corporation or an authorized Mitsubishi Semiconductor product distributor for further details on these materials or the products contained therein.




[^0]:    Notes1: Vector addresses contain interrupt jump destination addresses.
    2: Reset function in the same way as an interrupt with the highest priority.

[^1]:    Note: When an internal trigger is used in middle-speed mode, it is $14 \mu \mathrm{~s}$.

[^2]:    Note: When an internal trigger is used in middle-speed mode, it is $14 \mu \mathrm{~s}$.

